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April 1st, 2010
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3823 Group

List of Registers

1. Abstract

The following article introduces and shows the SFR registers of the 3823 Group.

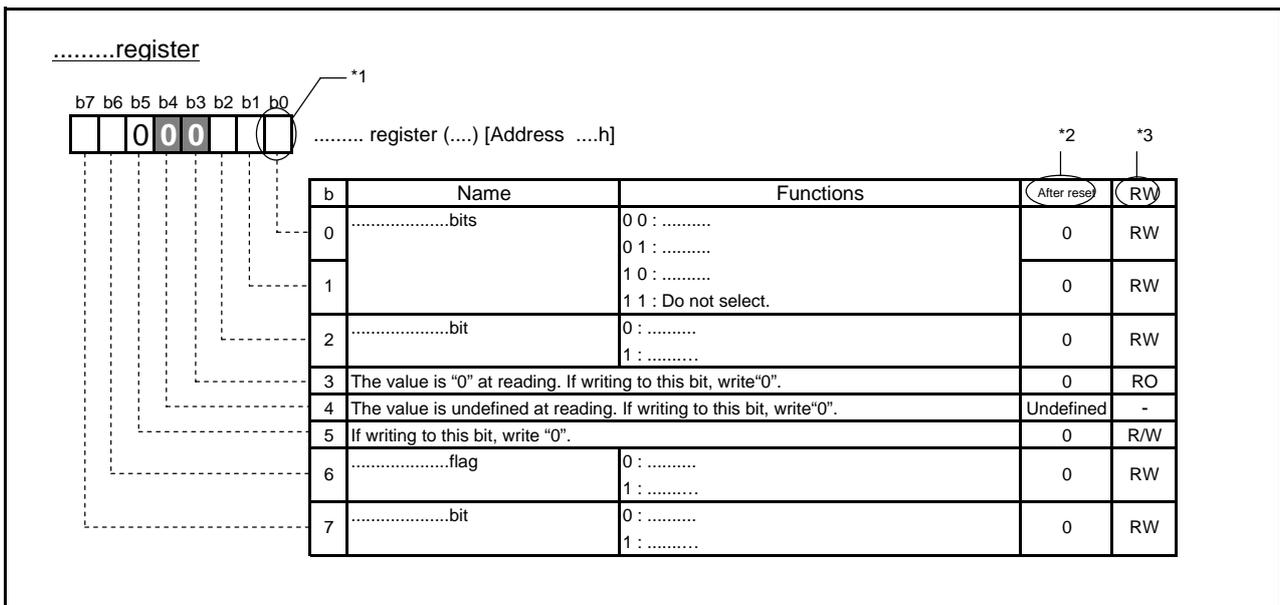
2. Introduction

The explanation of this issue is applied to the following MCU:

Applicable MCU: 3823 Group

3. Structure of Register

The following is an example of the SFR register structure figure used in this application note and definitions of codes or abbreviations used in this figure are explained below.



*1

Blank : Set "1" or "0" to this bit according to use.
 0 : If writing to this bit, write "0".
 1 : If writing to this bit, write "1".
 x : This bit is not used in the specific mode or state.
 : Nothing is arranged for this bit.

*2

0 : "0" after reset
 1 : "1" after reset
 Undefined : Undefined after reset

*3

RW : Read enabled. Write enabled.
 RO : Read enabled. This value depends on each bit at writing.
 WO : Write enabled. Undefined at reading.
 - : Undefined at reading. This value depends on each bit at writing.

4. List of Registers

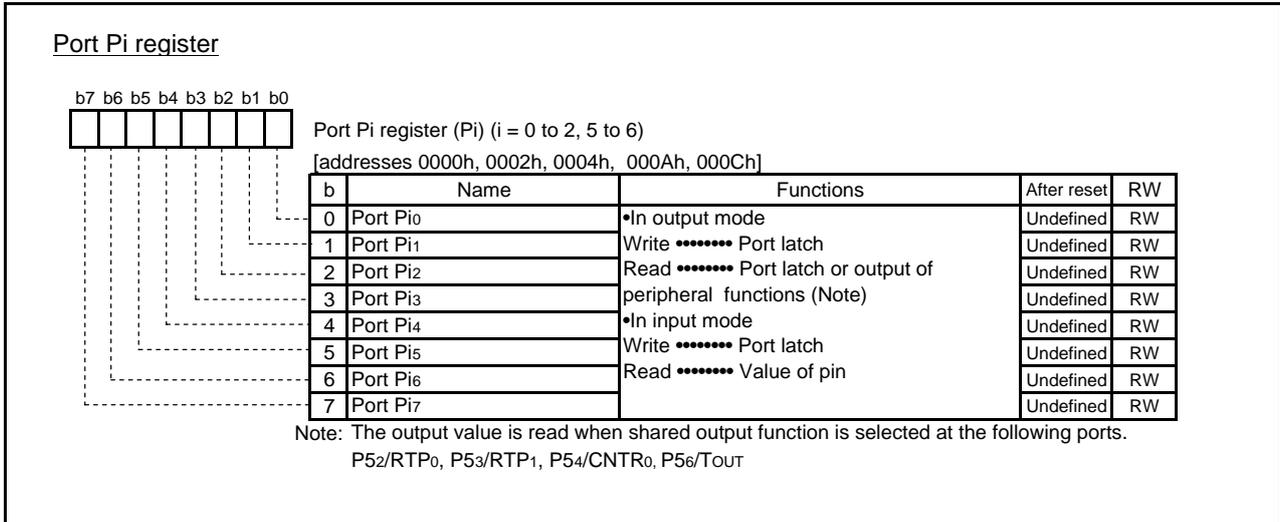


Fig. 4.1 Structure of Port Pi register (i = 0 to 2, 5 to 6)

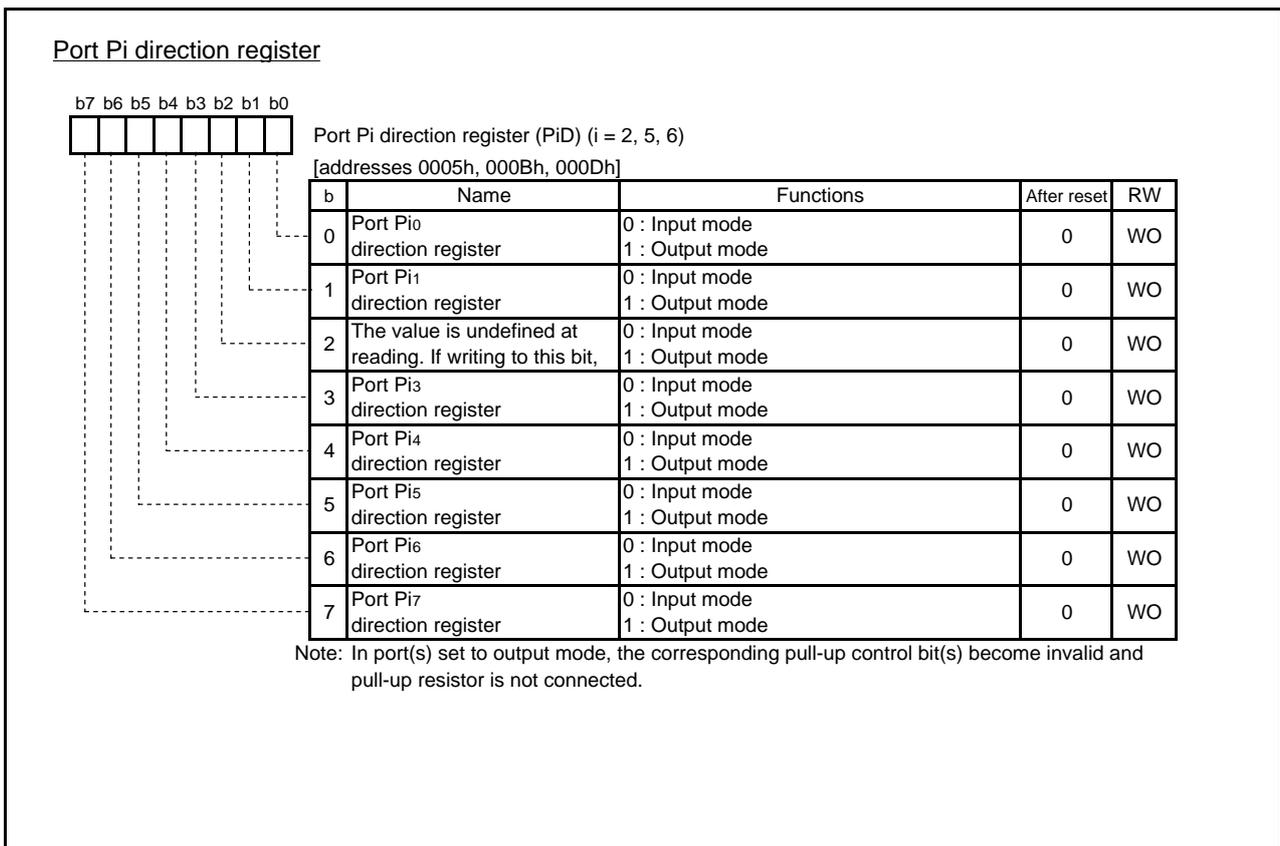


Fig. 4.2 Structure of Port Pi direction register (i = 2, 5, 6)

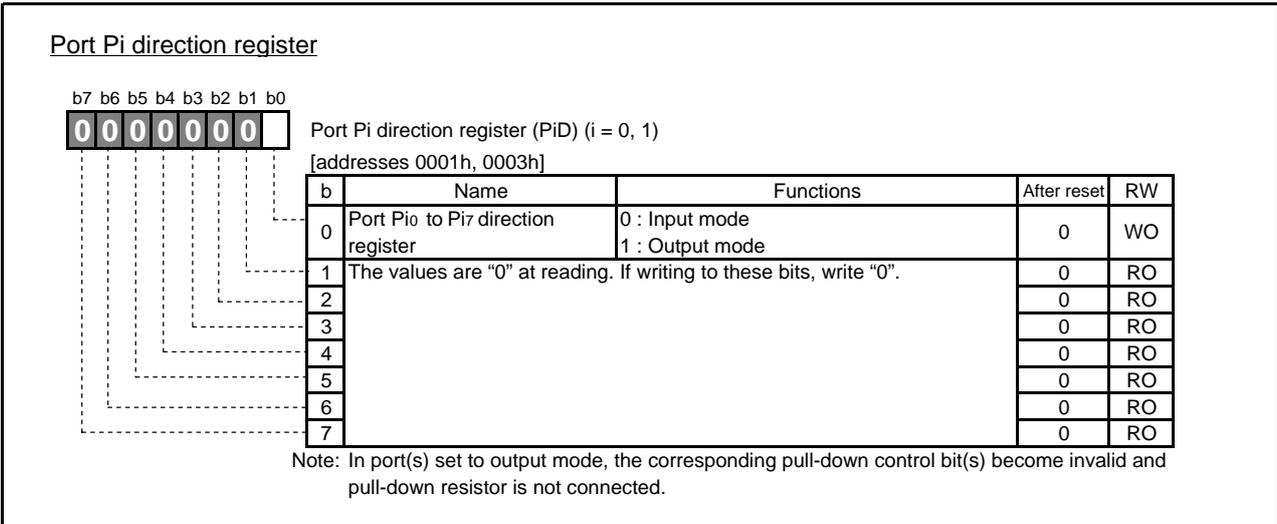


Fig. 4.3 Structure of Port Pi direction register (i = 0, 1)

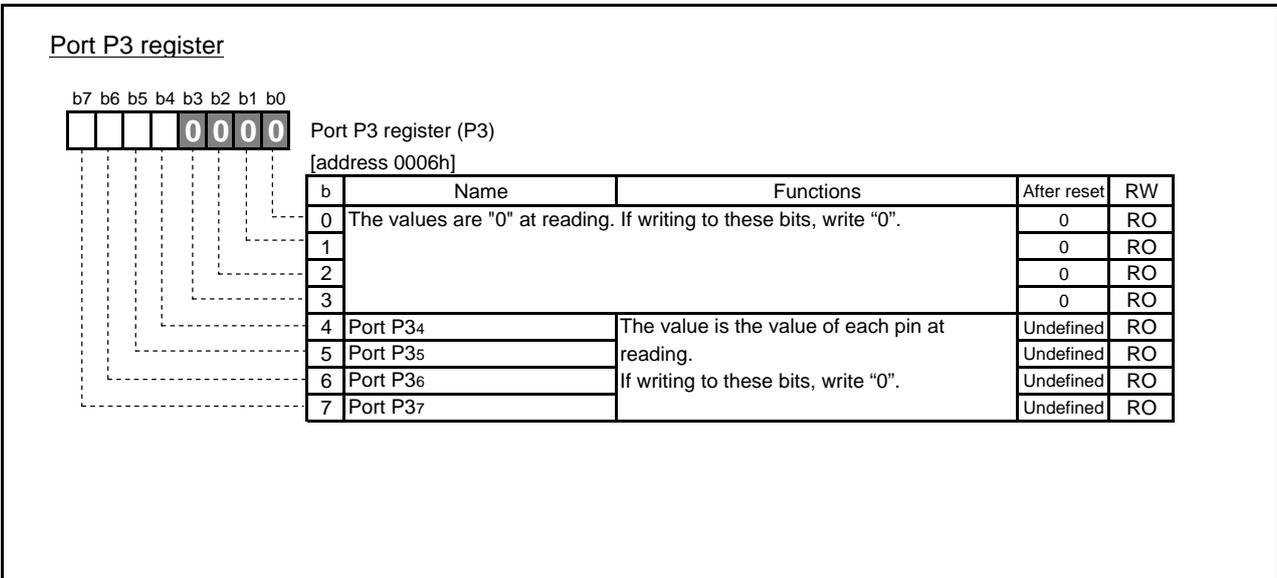


Fig. 4.4 Structure of Port P3 register

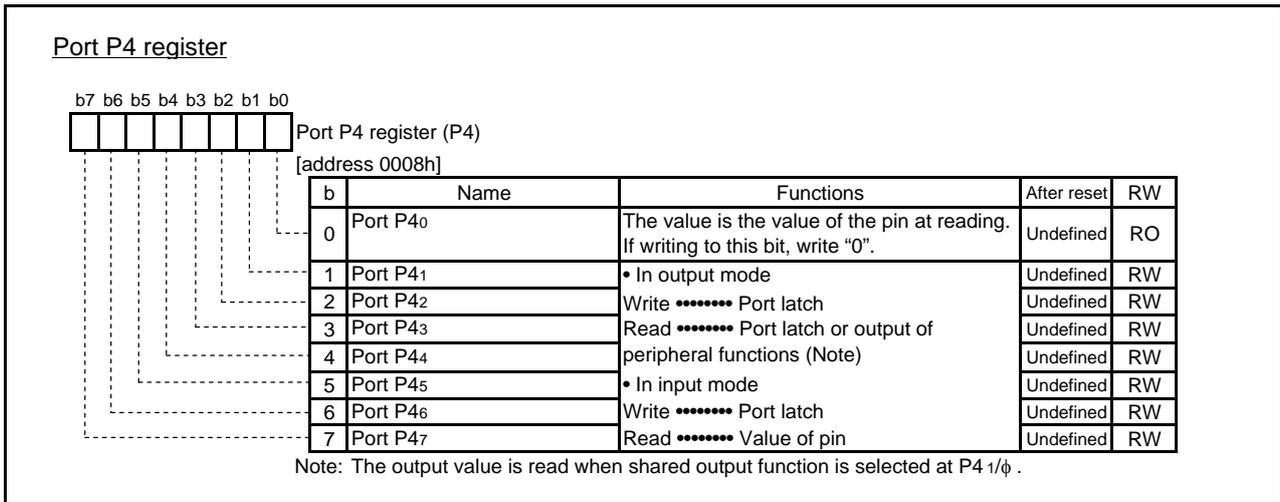


Fig. 4.5 Structure of Port P4 register

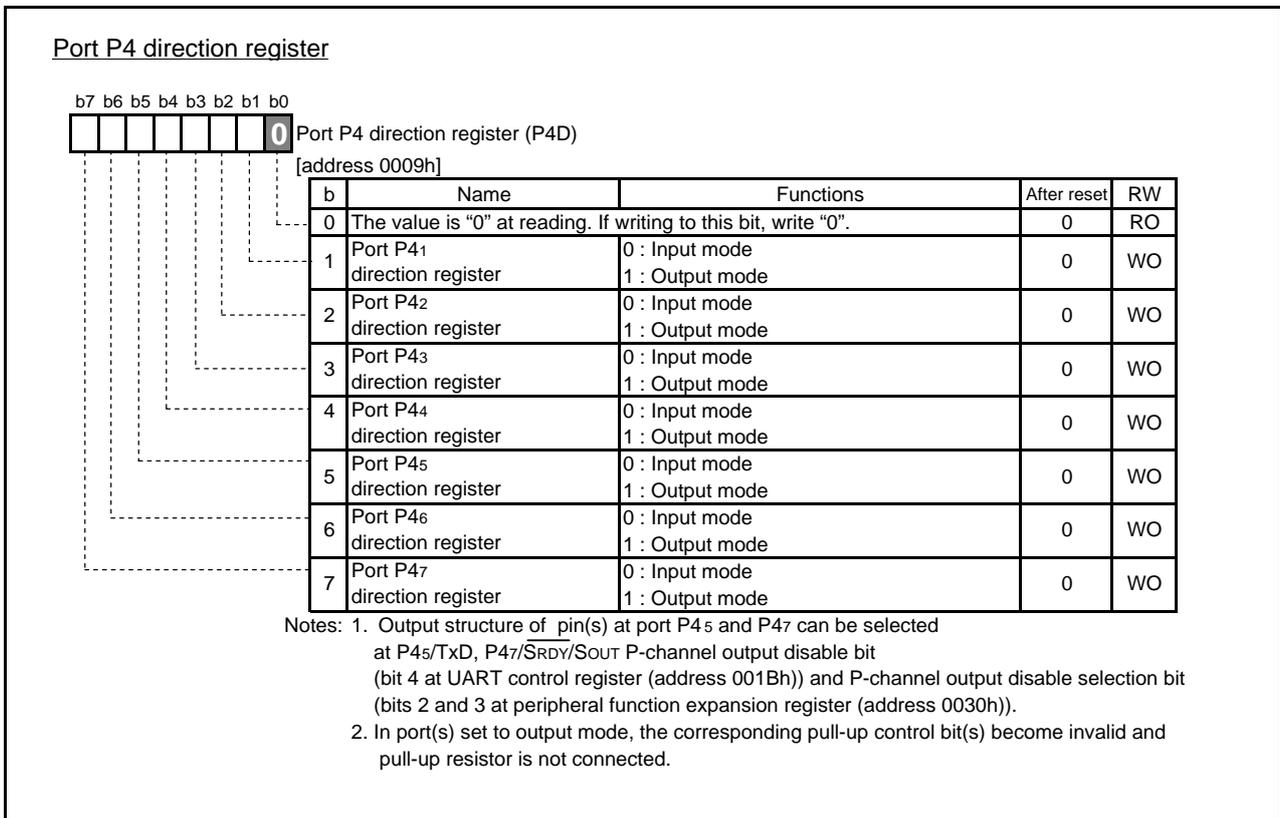


Fig. 4.6 Structure of Port P4 direction register

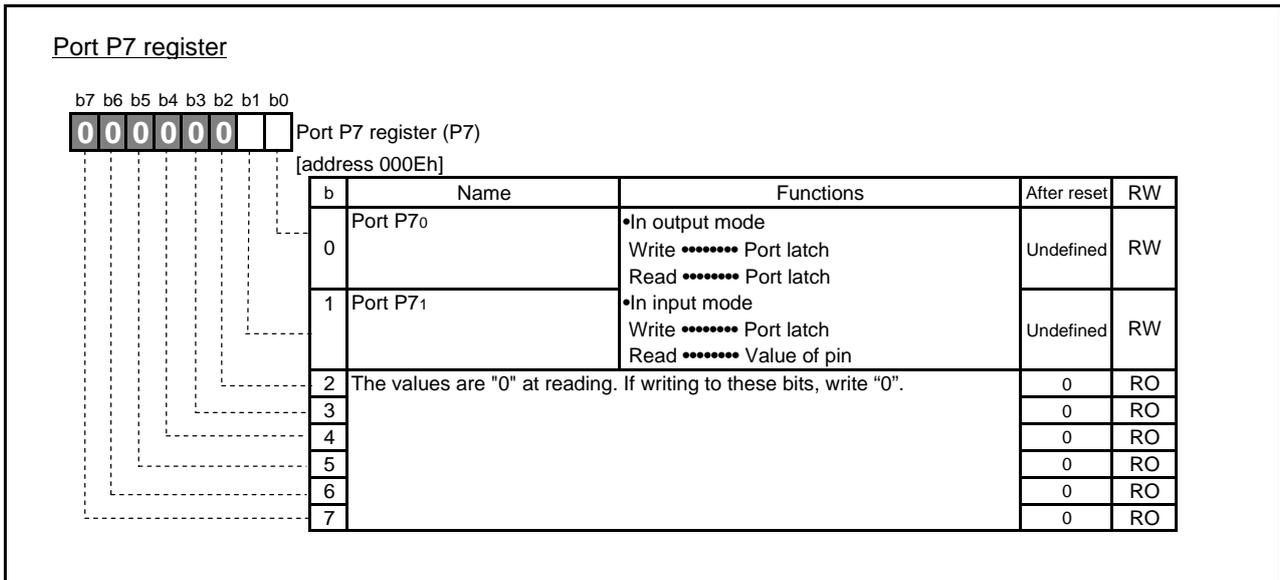


Fig.4.7 Structure of Port P7 register

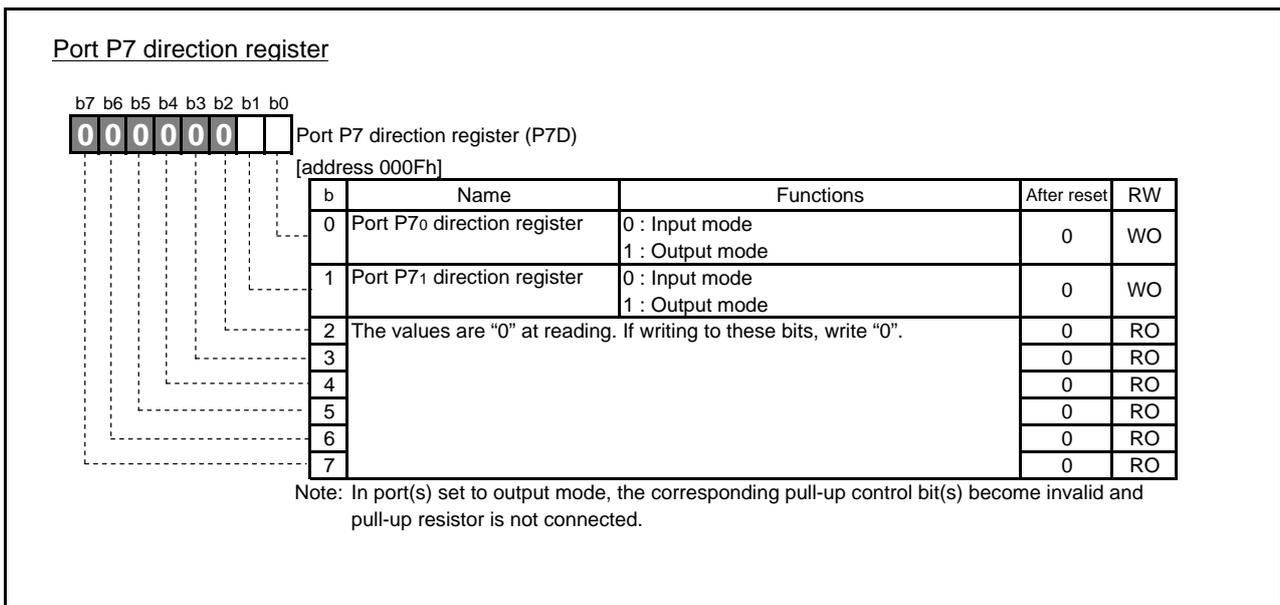
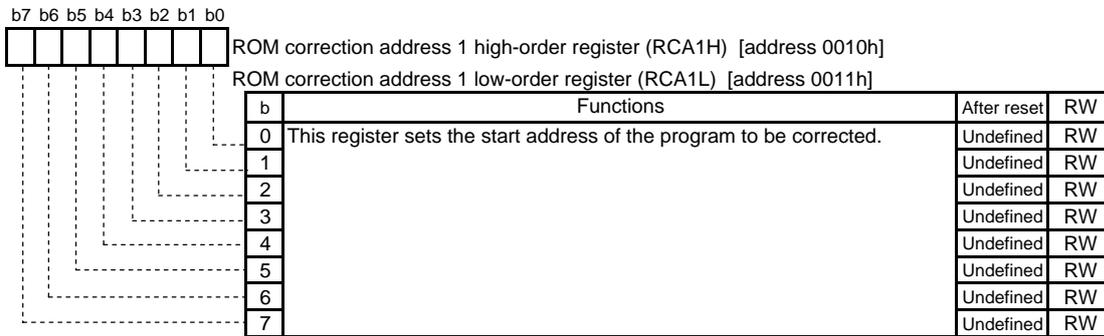


Fig.4.8 Structure of Port P7 direction register

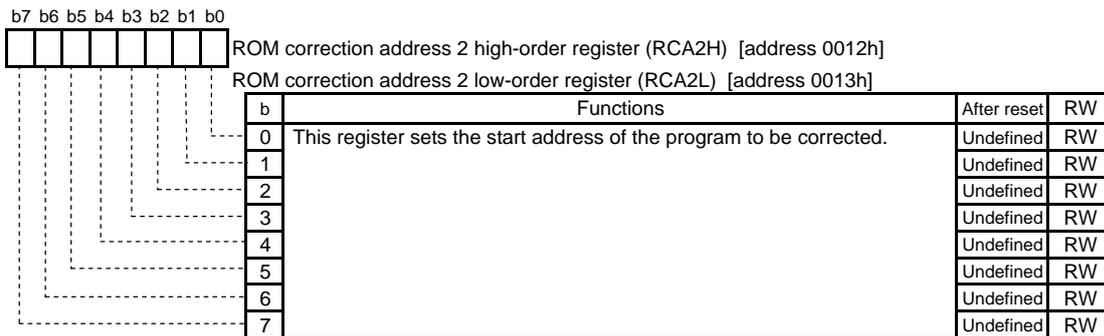
ROM correction address 1 high-order register, ROM correction address 1 low-order register



Notes: 1. Specify the start address of each instruction (operation code address) as ROM correction address.
 2. Do not set any addresses other than those located in the ROM area to ROM correction address registers. Do not set the same addresses to both ROM correction address 1 registers and ROM correction address 2 registers.

Fig.4.9 Structure of ROM correction address 1 high-order register, ROM correction address 1 low-order register

ROM correction address 2 high-order register, ROM correction address 2 low-order register



Notes: 1. Specify the start address of each instruction (operation code address) as ROM correction address.
 2. Do not set any addresses other than those located in the ROM area to ROM correction address registers. Do not set the same addresses to both ROM correction address 1 registers and ROM correction address 2 registers.

Fig.4.10 Structure of ROM correction address 2 high-order register, ROM correction address 2 low-order register

ROM correction enable register

b7 b6 b5 b4 b3 b2 b1 b0



ROM correction enable register (RCR)

[address 0014h]

b	Name	Functions	After reset	RW
0	Address 1 enable bit (RC0)	0 : Disable 1 : Enable	0	RW
1	Address 2 enable bit (RC1)	0 : Disable 1 : Enable	0	RW
2	The values are "0" at reading. If writing to these bits, write "0".		0	RO
3			0	RO
4			0	RO
5			0	RO
6			0	RO
7			0	RO

Note: When using ROM correction function, make sure to enable address enable bits after setting ROM correction address registers.

Fig.4.11 Structure of ROM correction enable register

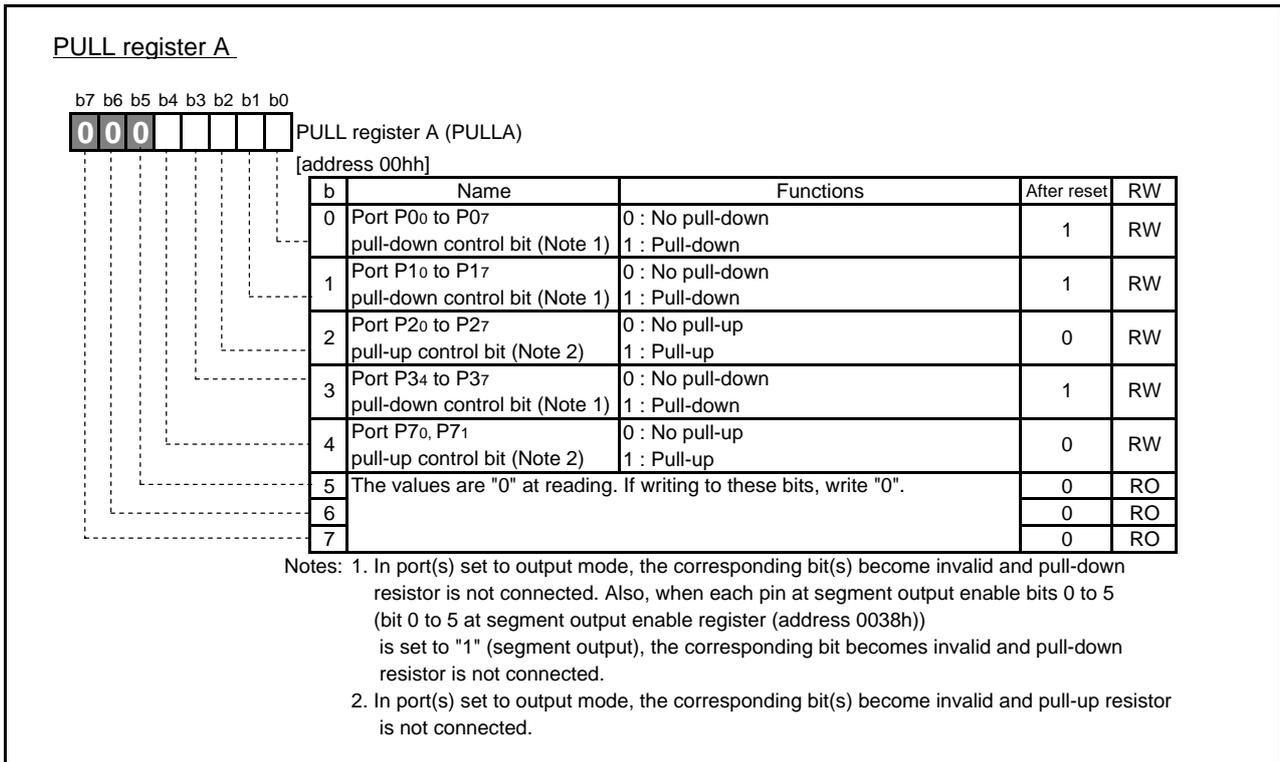


Fig. 4.12 Structure of PULL register A

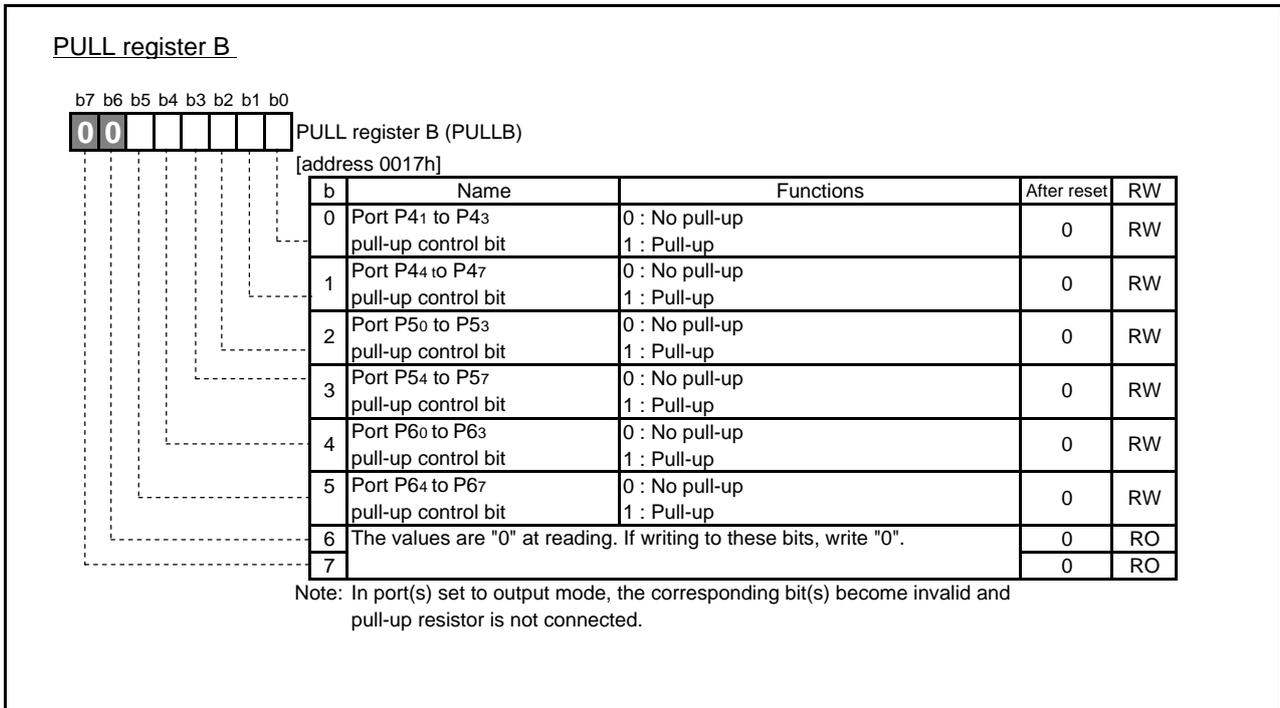


Fig. 4.13 Structure of PULL register B

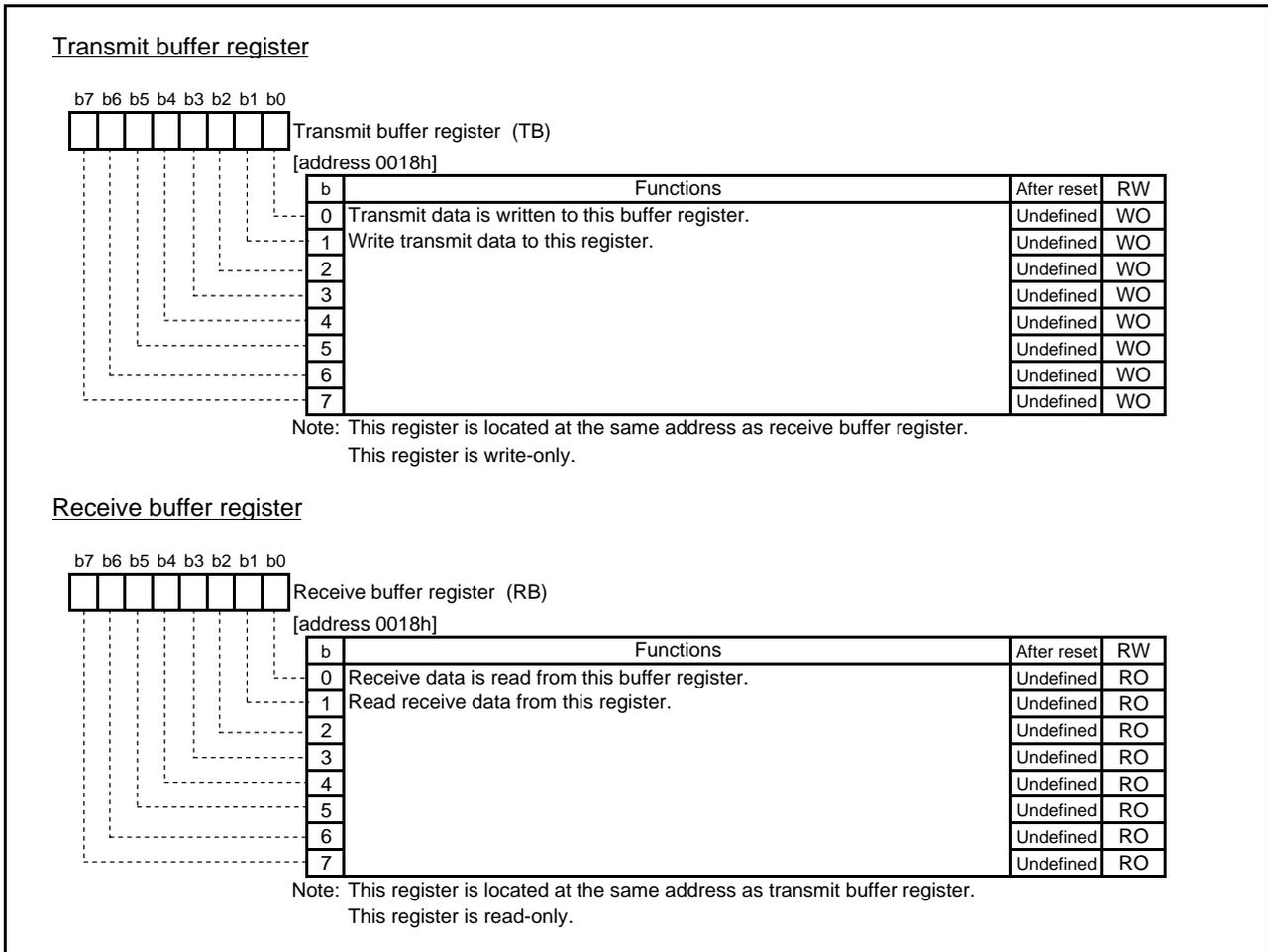


Fig.4.14 Structure of Transmit buffer register / Receive buffer register

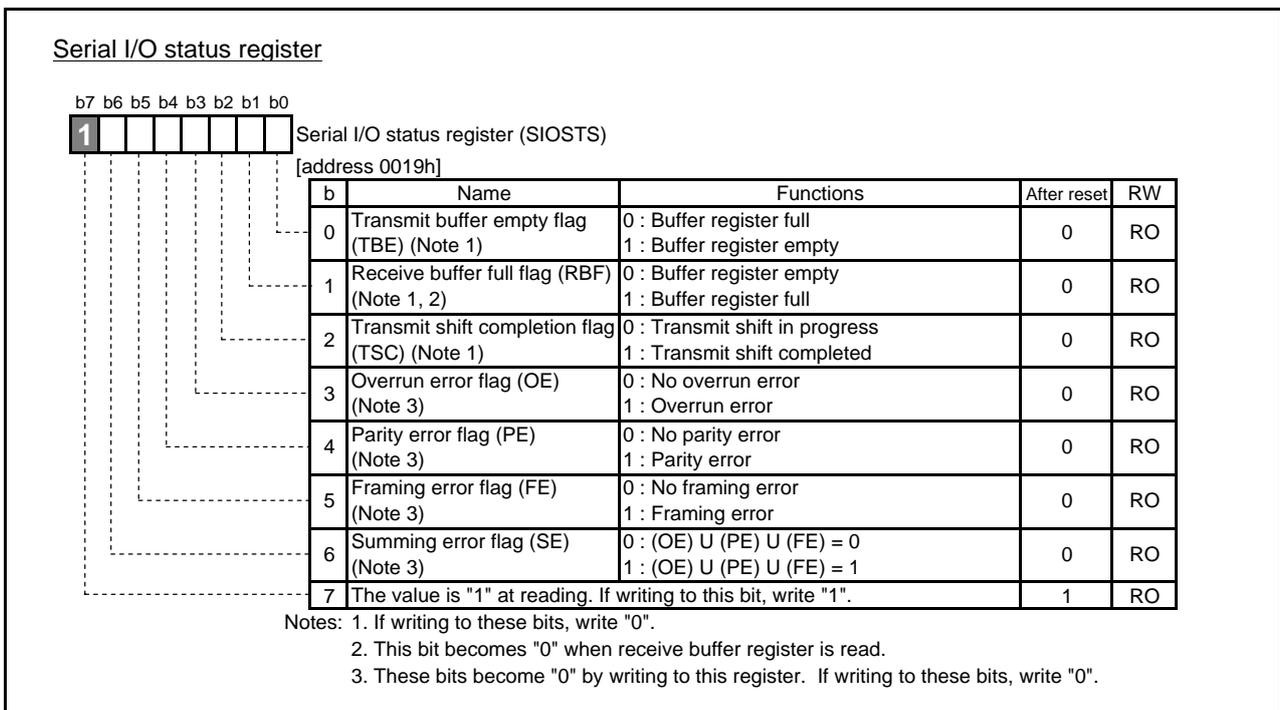


Fig. 4.15 Structure of Serial I/O status register

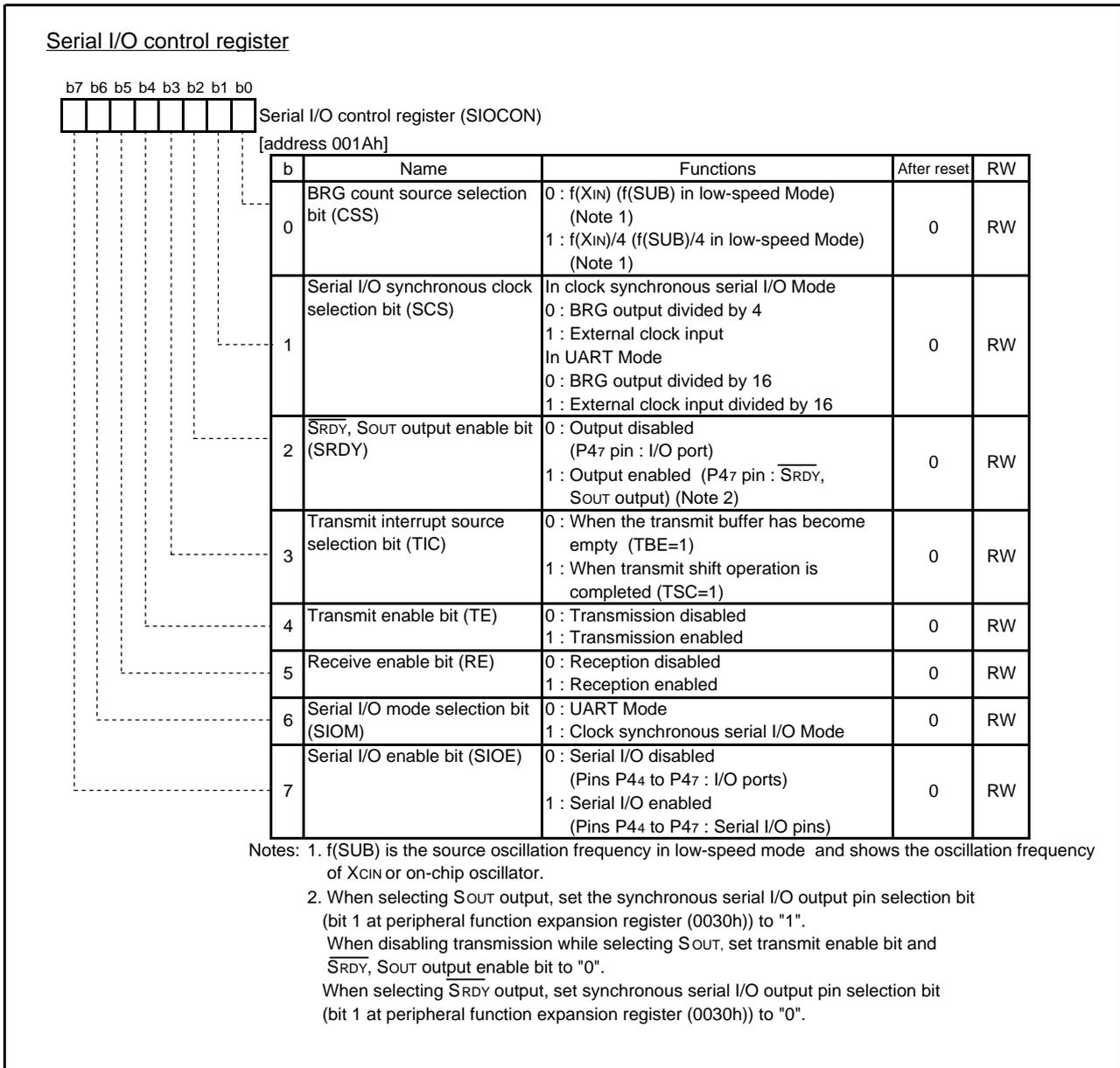


Fig. 4.16 Structure of Serial I/O control register

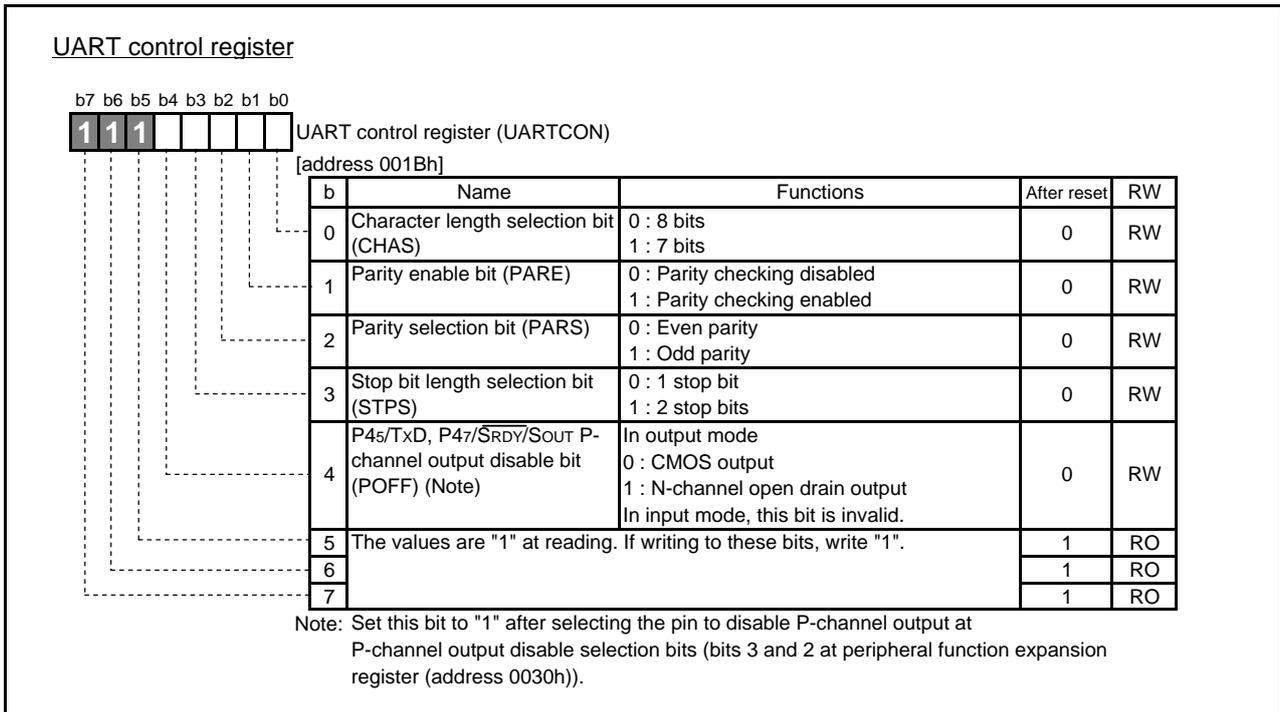


Fig. 4.17 Structure of UART control register

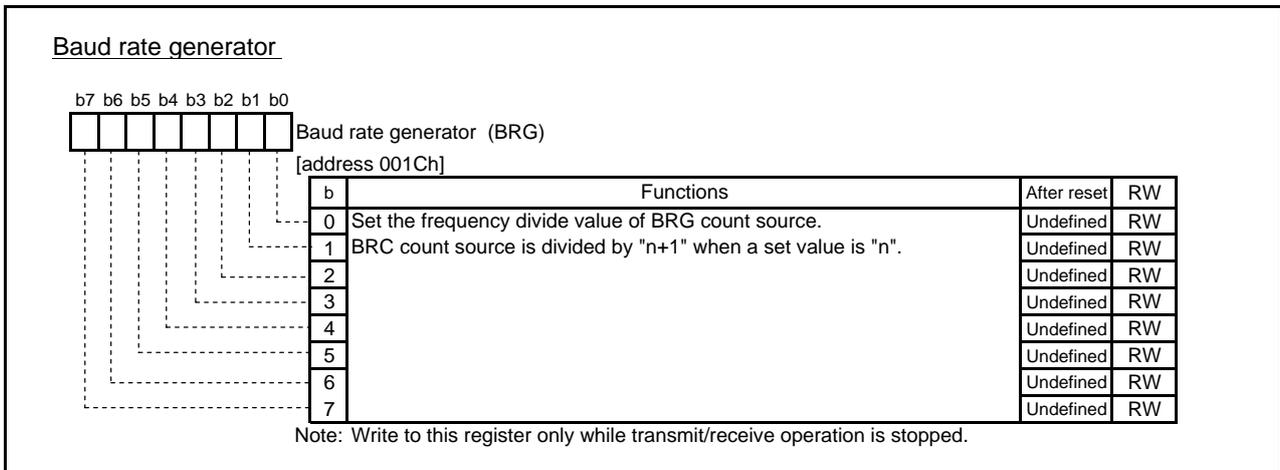
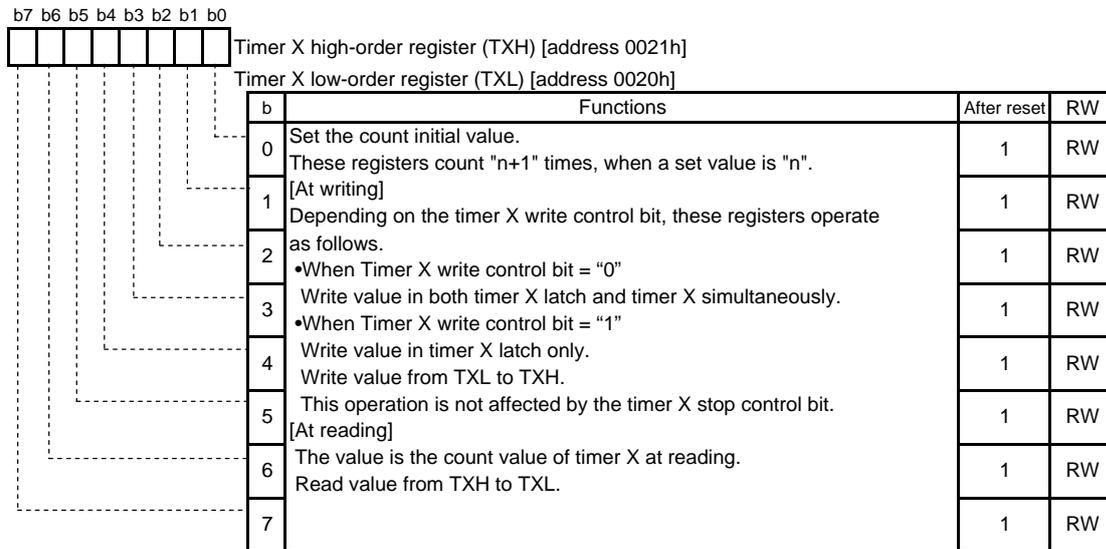


Fig.4.18 Structure of Baud rate generator

Timer X high-order register , Timer X low-order register



Note: When underflow and writing to high-order timer latch occur almost at the same time while selecting writing to timer latch only, the value is set to timer and timer latch simultaneously. At this time, any unexpected values may be set to high-order timer.

Fig.4.19 Structure of Timer X high-order register , Timer X low-order register

Timer Y high-order register , Timer Y low-order register

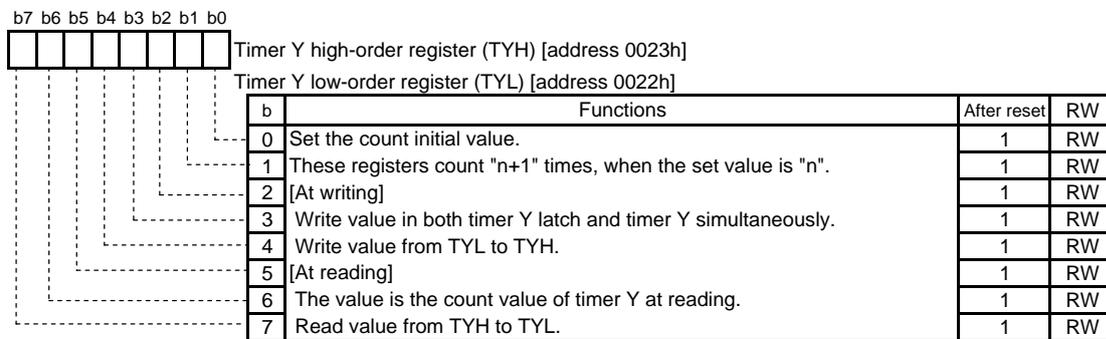


Fig.4.20 Structure of Timer Y high-order register, Timer Y low-order register

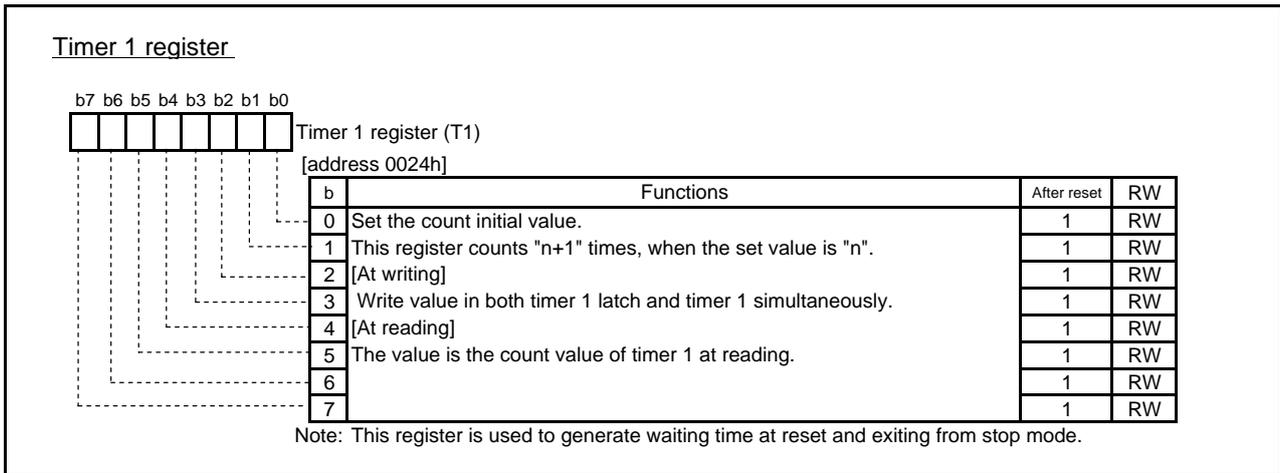


Fig.4.21 Structure of Timer 1 register

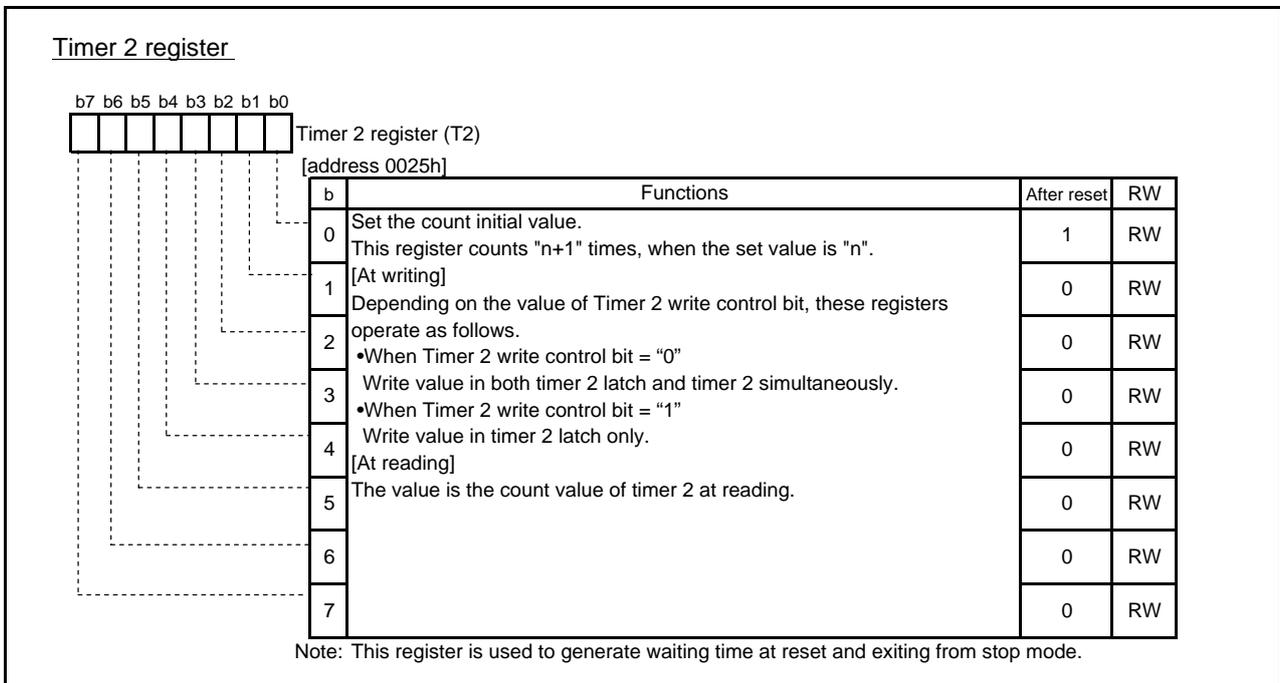


Fig.4.22 Structure of Timer 2 register

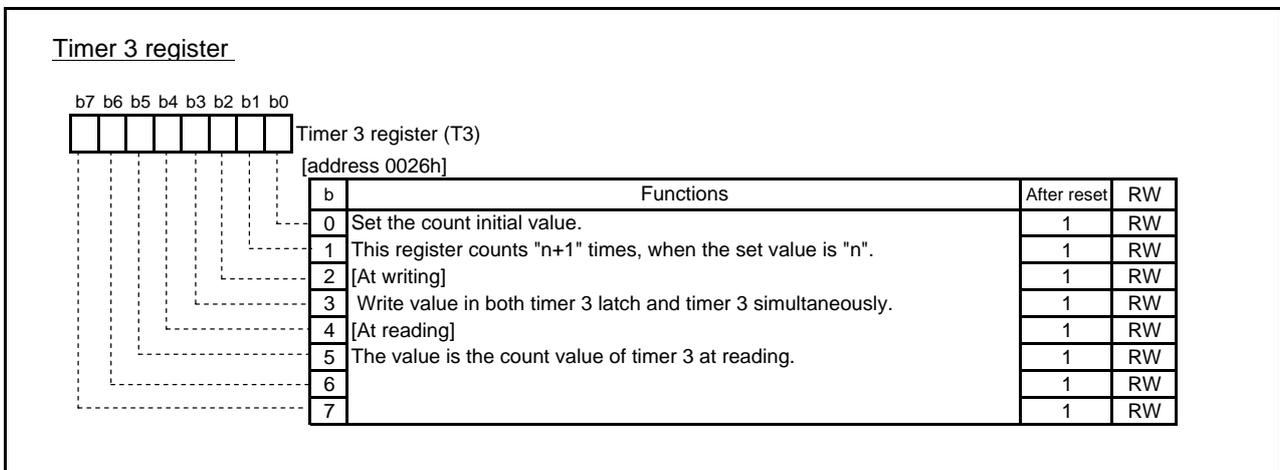


Fig.4.23 Structure of Timer 3 register

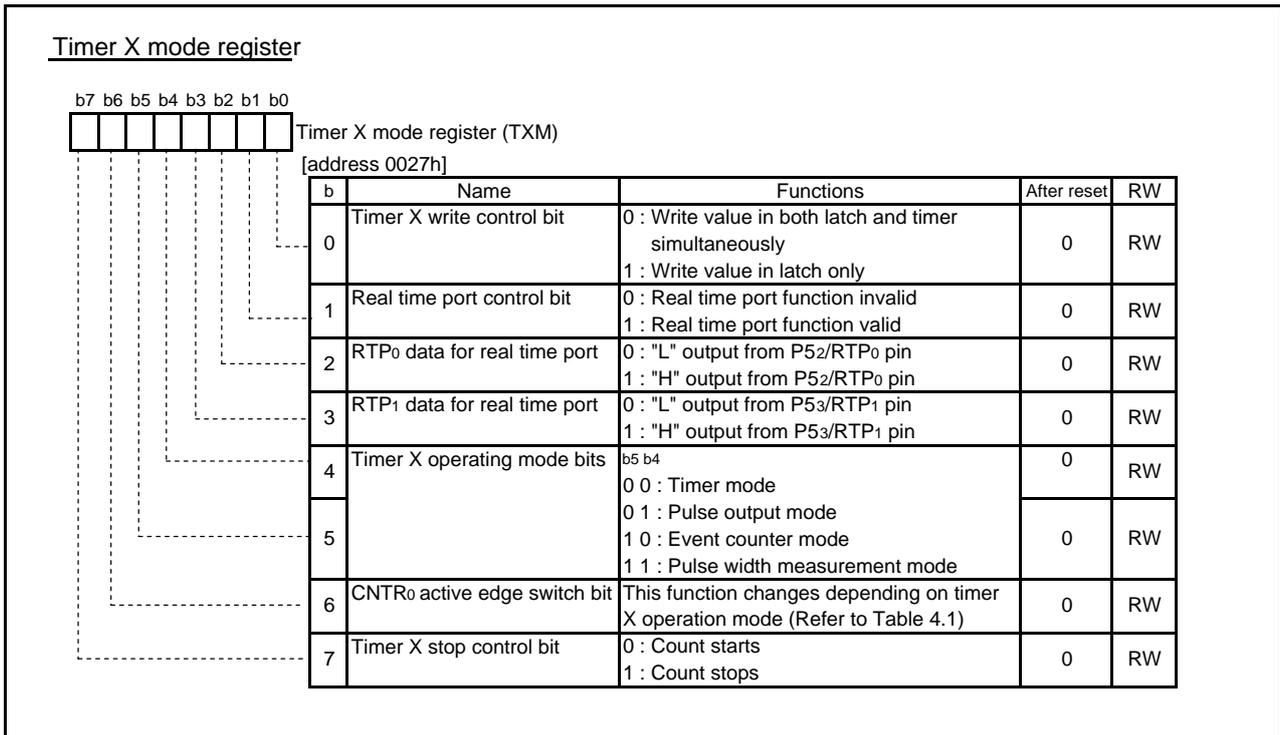


Fig.4.24 Structure of Timer X mode register

Table 4.1 CNTR0 active edge switch bit function

Timer X operation mode	Set value	Timer function/CNTR0 pin function	CNTR0 Interrupt request occurrence source
Timer mode	"0"	External interrupt pin	CNTR0 input signal falling edge (No influence on timer count)
	"1"		CNTR0 input signal rising edge (No influence on timer count)
Pulse output mode	"0"	Pulse output start from "H"	Output signal falling edge
	"1"	Pulse output start from "L"	Output signal rising edge
Event counter mode	"0"	Count at rising edge	Input signal falling edge
	"1"	Count at falling edge	Input signal rising edge
Pulse width measurement mode	"0"	Measure "H" pulse width	Input signal falling edge
	"1"	Measure "L" pulse width	Input signal rising edge

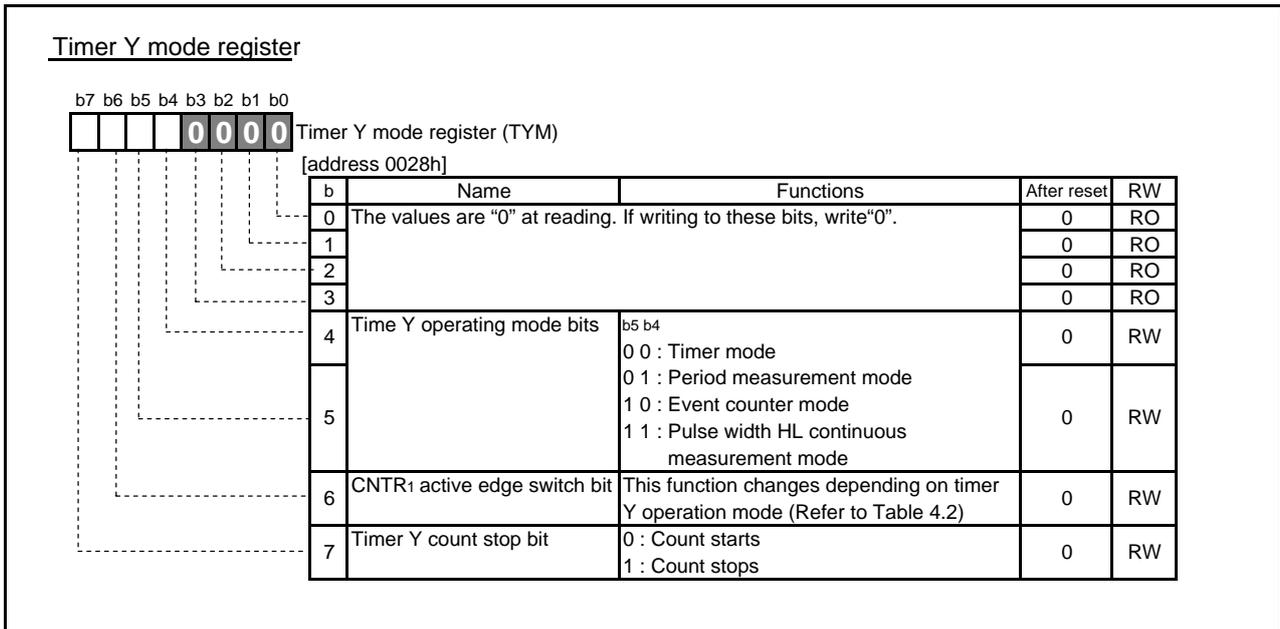


Fig.4.25 Structure of Timer Y mode register

Table 4.2 CNTR1 active edge switch bit function

Timer Y operation mode	Set value	Timer function selection	CNTR1 interrupt request occurrence source
Timer mode	"0"	External interrupt pin	CNTR1 input signal falling edge (No influence on timer count)
	"1"		CNTR1 input signal rising edge (No influence on timer count)
Period measurement mode	"0"	Measure the period from falling edge to falling edge	Input signal falling edge
	"1"	Measure the period from rising edge to rising edge	Input signal rising edge
Event counter mode	"0"	Count at rising edge	Input signal falling edge
	"1"	Count at falling edge	Input signal rising edge
Pulse width HL continuous measurement mode	"0"	Measure "H" and "L" pulse width	Input signal falling and rising edges
	"1"		

Timer 123 mode register

b7 b6 b5 b4 b3 b2 b1 b0



Timer 123 mode register (T123M)

[address 0029h]

b	Name	Functions	After reset	RW
0	Tout output active edge switch bit	0 : Output starts from "H" level 1 : Output starts from "L" level	0	RW
1	Tout output control bit	0 : Tout output disabled (P5 ₆ pin : I/O port) 1 : Tout output enabled (P5 ₆ pin : T _{out} output pin)	0	RW
2	Timer 2 write control bit	0 : Write value to both latch and timer simultaneously 1 : Write data to latch only	0	RW
3	Timer 2 count source selection bit	0 : Timer 1 output signal 1 : f(X _{IN})/16 in medium/high speed mode f(SUB)/16 in low speed mode (Note 1)	0	RW
4	Timer 3 count source selection bit	0 : Timer 1 output signal 1 : f(X _{IN})/16 in medium/high-speed mode f(SUB)/16 in low-speed mode (Note 1)	0	RW
5	Timer 1 count source selection bit	0 : f(X _{IN})/16 in medium/high-speed mode f(SUB)/16 in low-speed mode (Note 1) 1 : f(SUB) (Note 1)	0	RW
6	The values are "0" at reading. If writing to these bits, write "0".		0	RO
7			0	RO

Notes: 1. f(SUB) is the source oscillation frequency in low-speed mode and shows the oscillation frequency of X_{CIN} or on-chip oscillator.

Internal system clock ϕ is f(SUB)/2 in low-speed mode.

2. Set the value of timer in the order of timer 1 register, timer 2 register, and timer 3 register after setting the count source of timer 1, 2 and 3.

Fig.4.26 Structure of Timer 123 mode register

ϕ output control register

b7 b6 b5 b4 b3 b2 b1 b0



ϕ output control register (CKOUT)

[address 002Ah]

b	Name	Functions	After reset	RW
0	ϕ output control bit	0 : Port function (P4 ₁ pin : I/O port) 1 : Internal system clock ϕ output, or X _{CIN} frequency signal output (Note) (P4 ₁ pin : ϕ output pin)	0	RW
1	The values are "0" at reading. If writing to these bits, write "0".		0	RO
2			0	RO
3			0	RO
4			0	RO
5			0	RO
6			0	RO
7			0	RO

Note: Set output clock selection bit (bit 4 at peripheral function expansion register (address 0030h)) and port P4₁ direction register to "1" when X_{CIN} frequency signal is output.

Fig.4.27 Structure of ϕ output control register

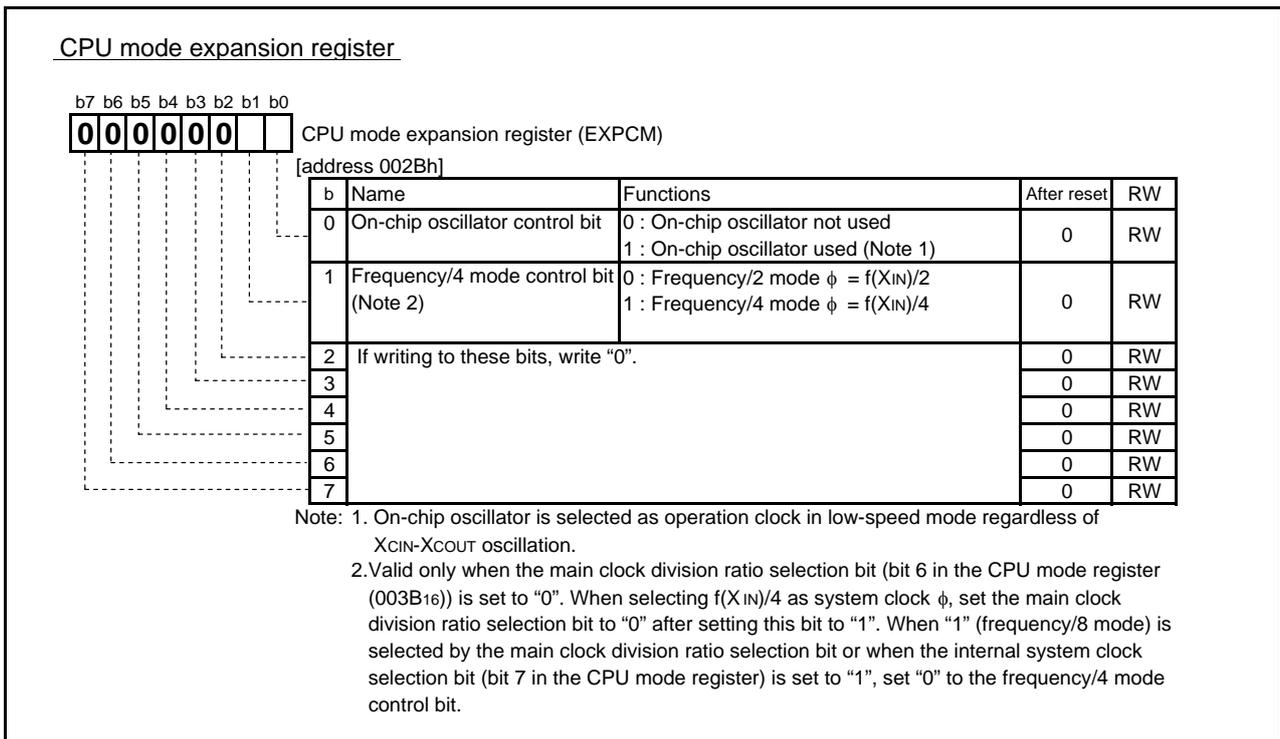


Fig.4.28 Structure of CPU mode expansion register

Temporary data register 0

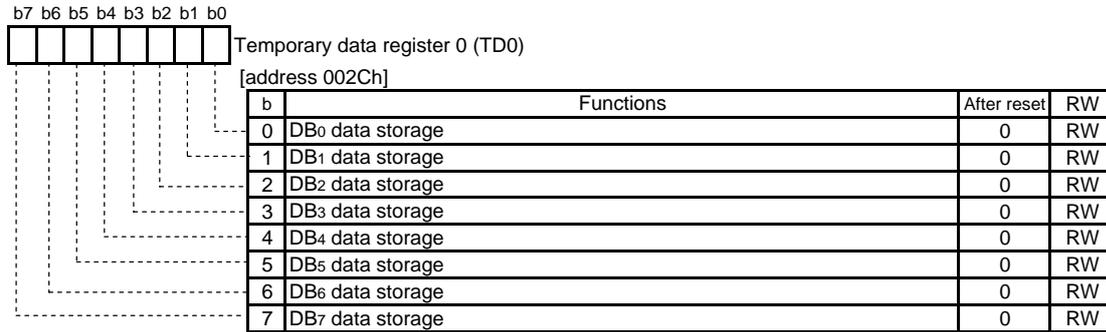


Fig.4.29 Structure of Temporary data register 0

Temporary data register 1

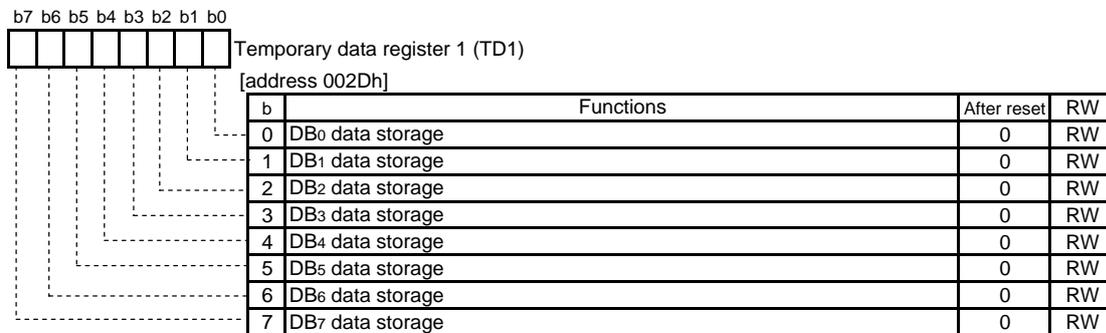


Fig.4.30 Structure of Temporary data register 1

Temporary data register 2

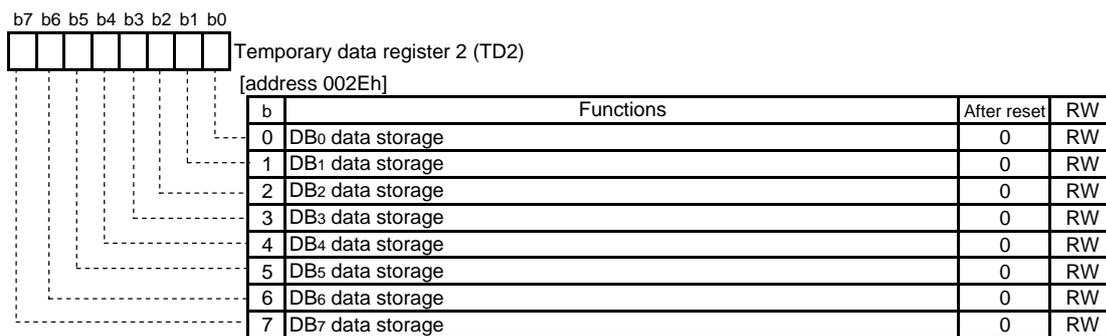


Fig.4.31 Structure of Temporary data register 2

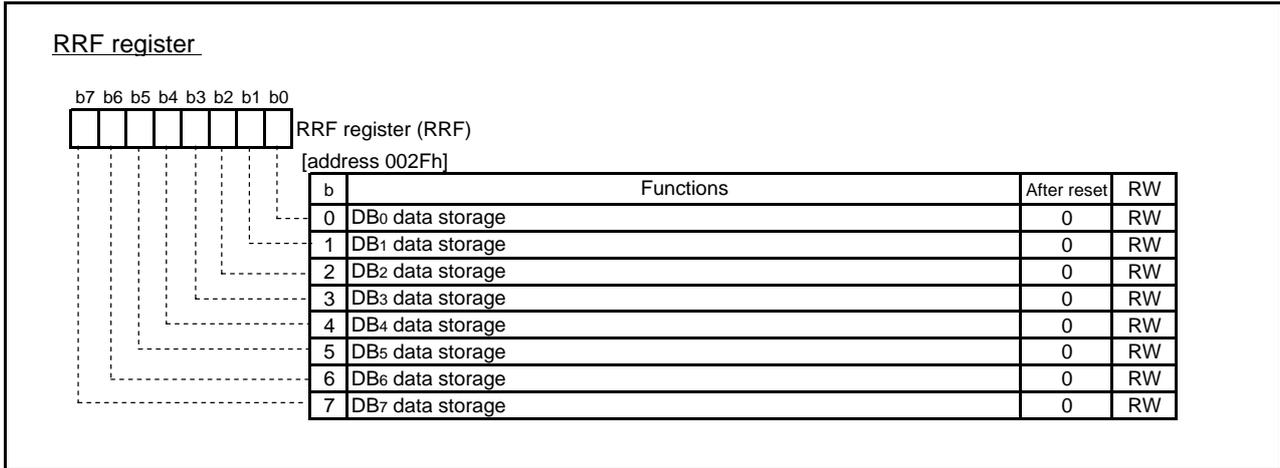


Fig.4.32 Structure of RRF register

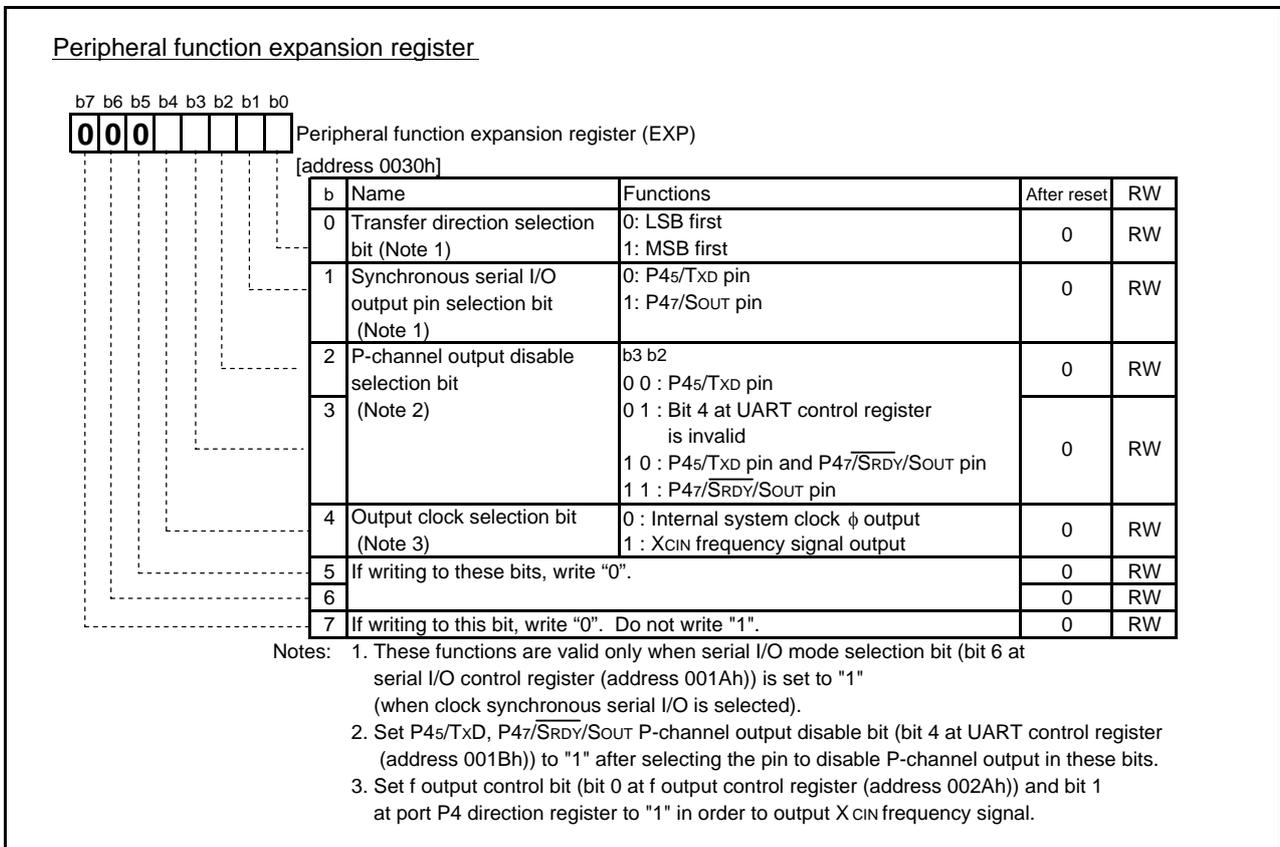


Fig.4.33 Structure of Peripheral function expansion register

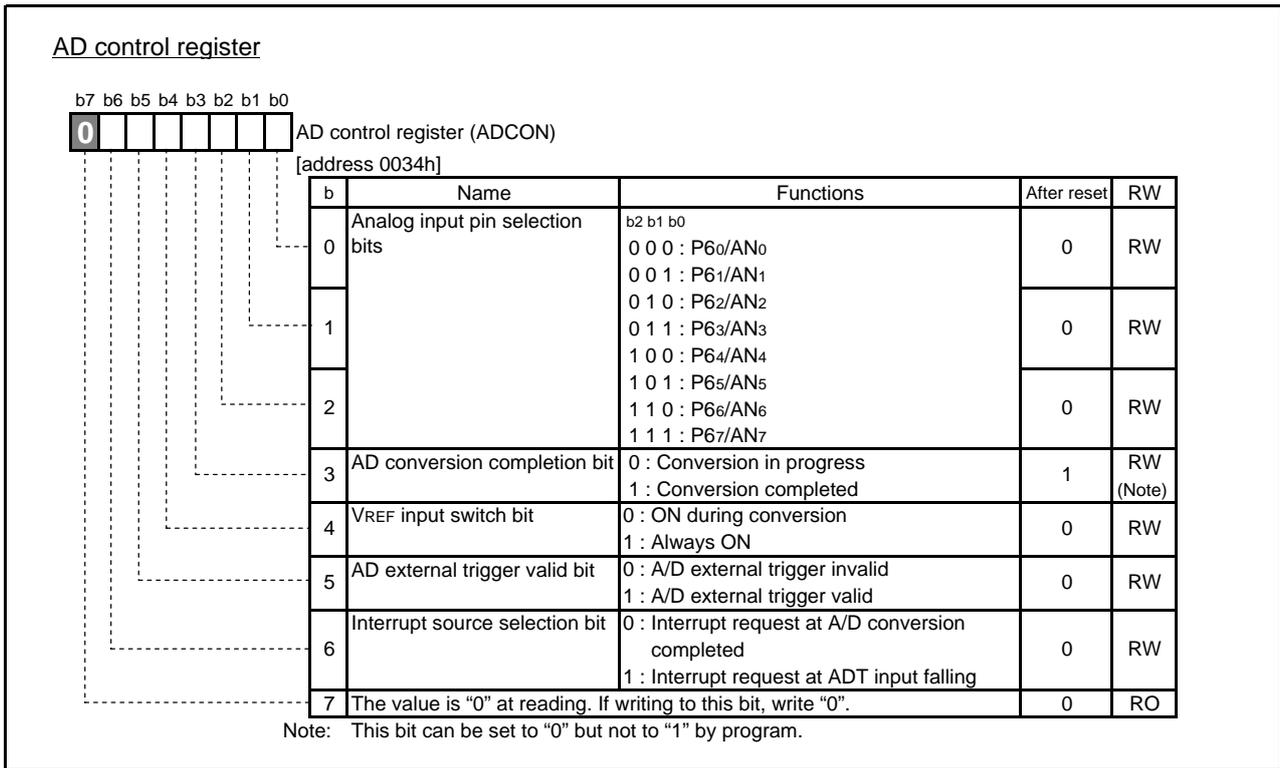


Fig.4.34 Structure of AD control register

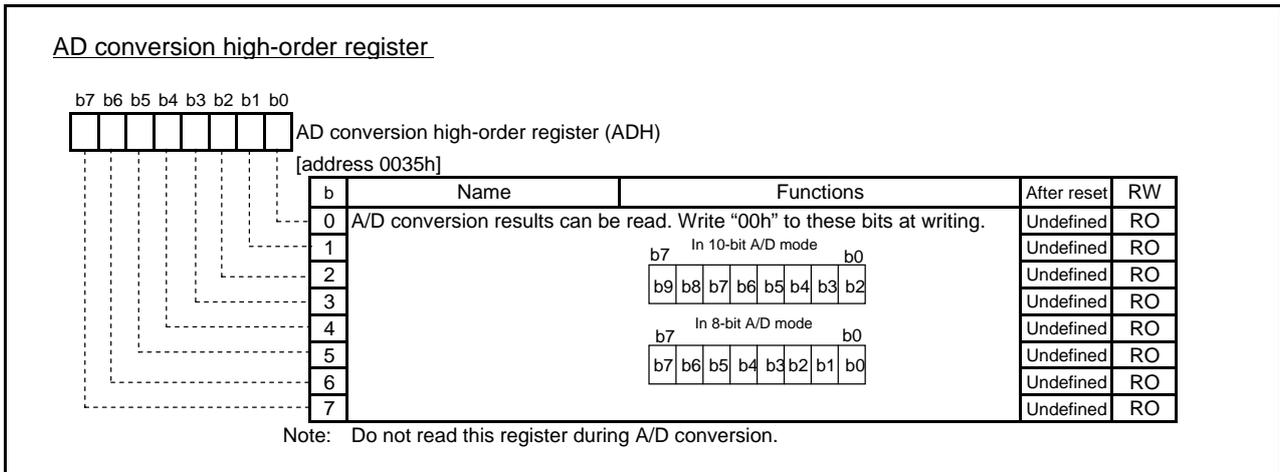


Fig.4.35 Structure of AD conversion high-order register

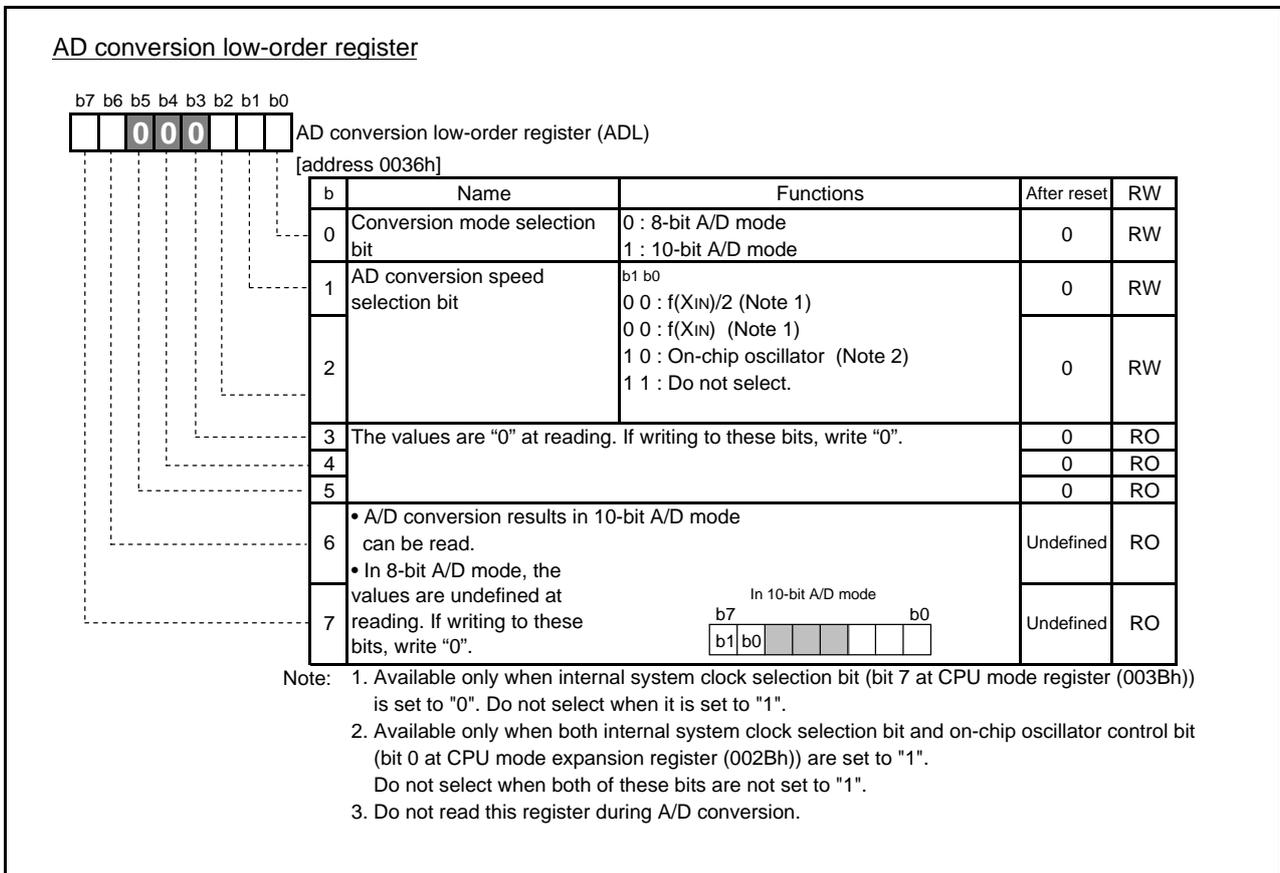


Fig.4.36 Structure of AD conversion low-order register

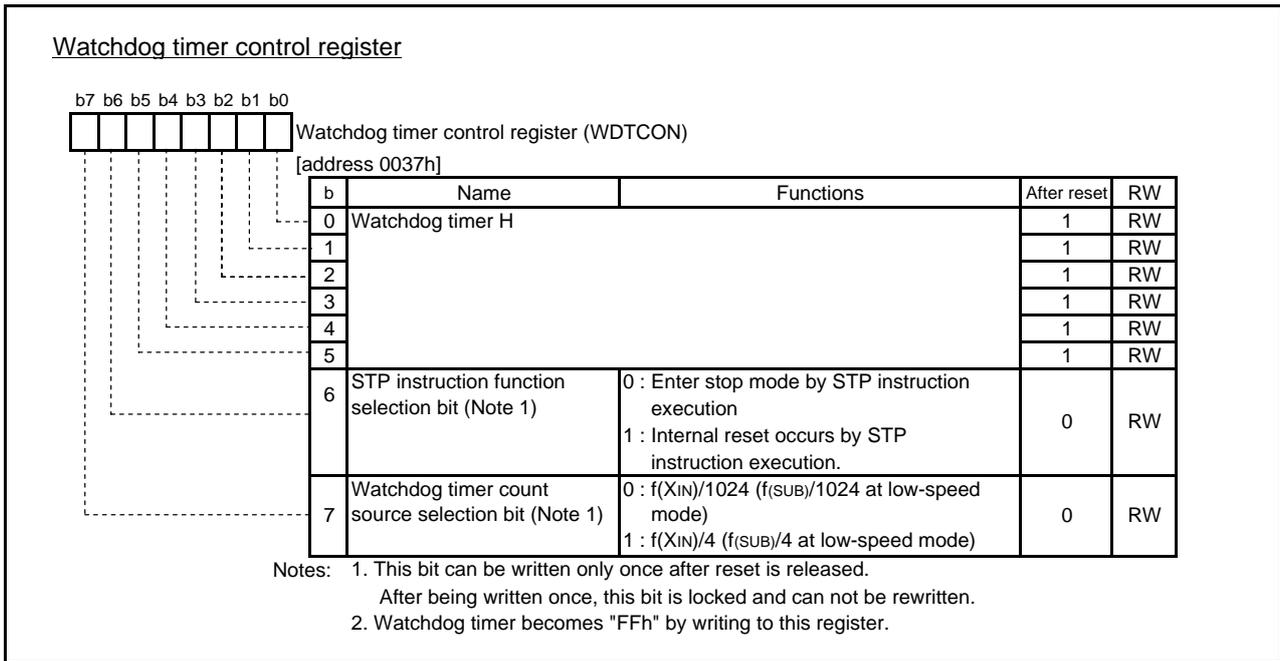


Fig.4.37 Structure of Watchdog timer control register

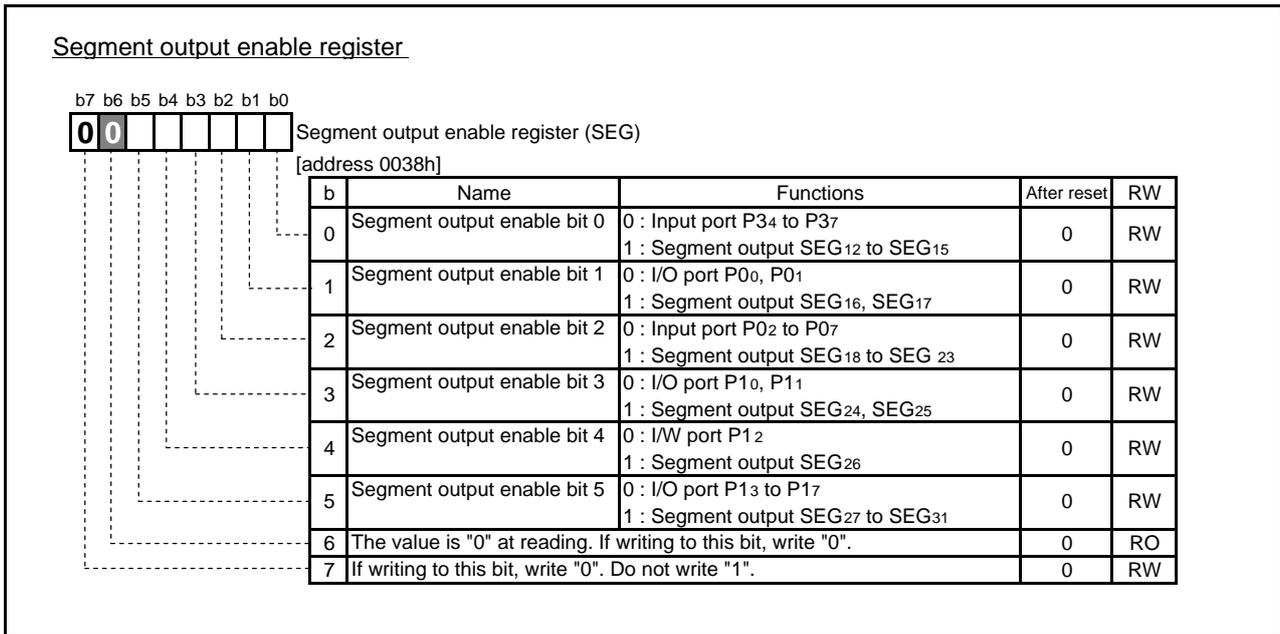


Fig.4.38 Structure of Segment output enable register

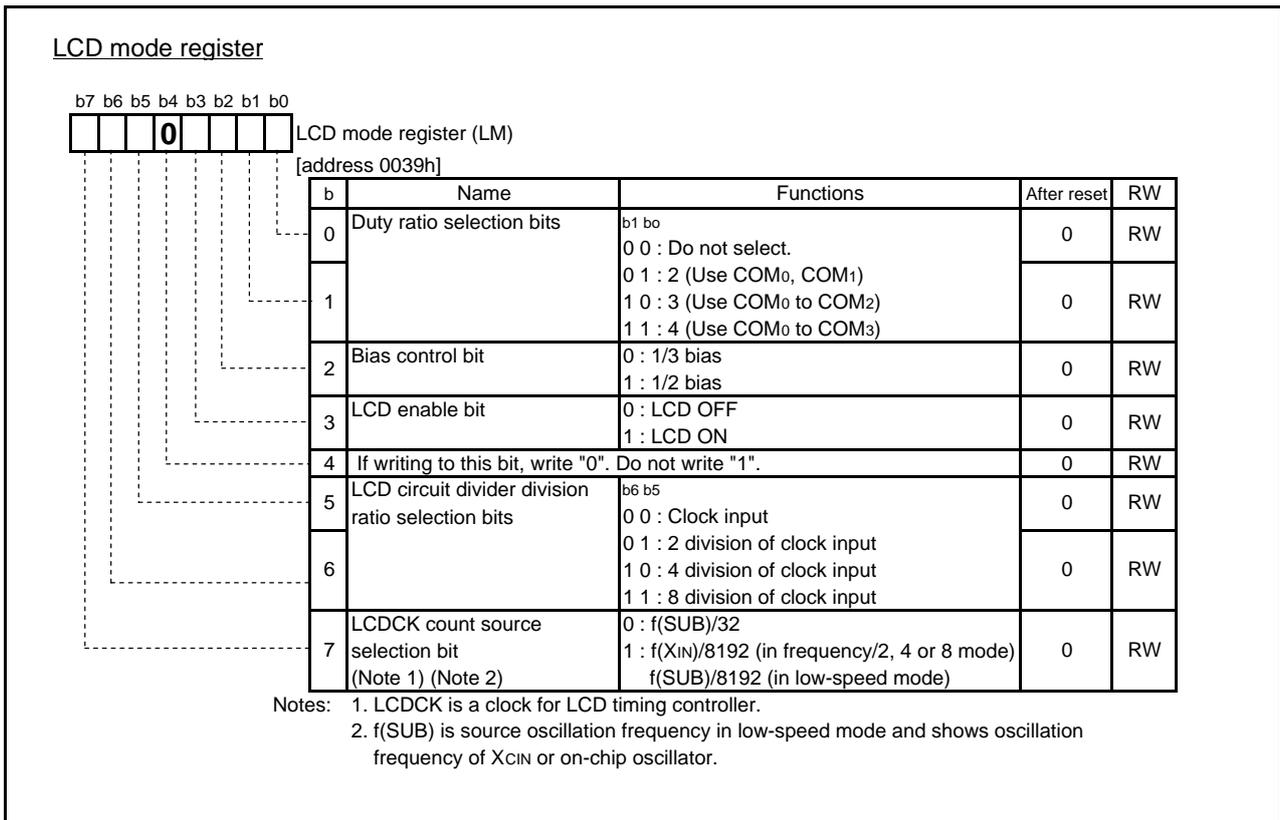


Fig.4.39 Structure of LCD mode register

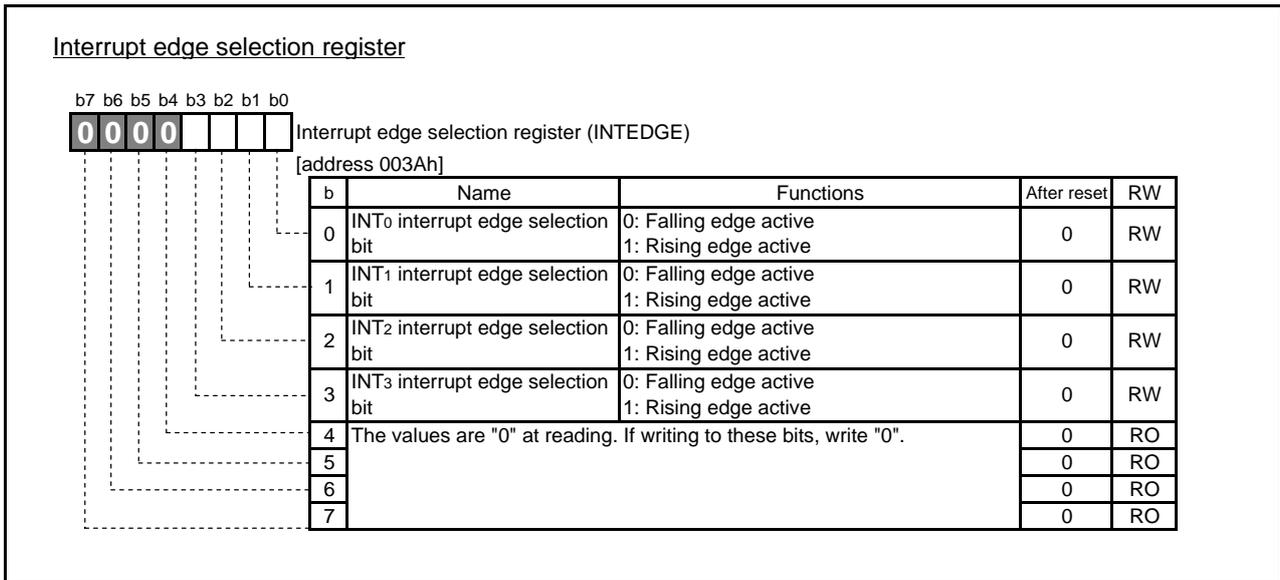


Fig.4.40 Structure of Interrupt edge selection register

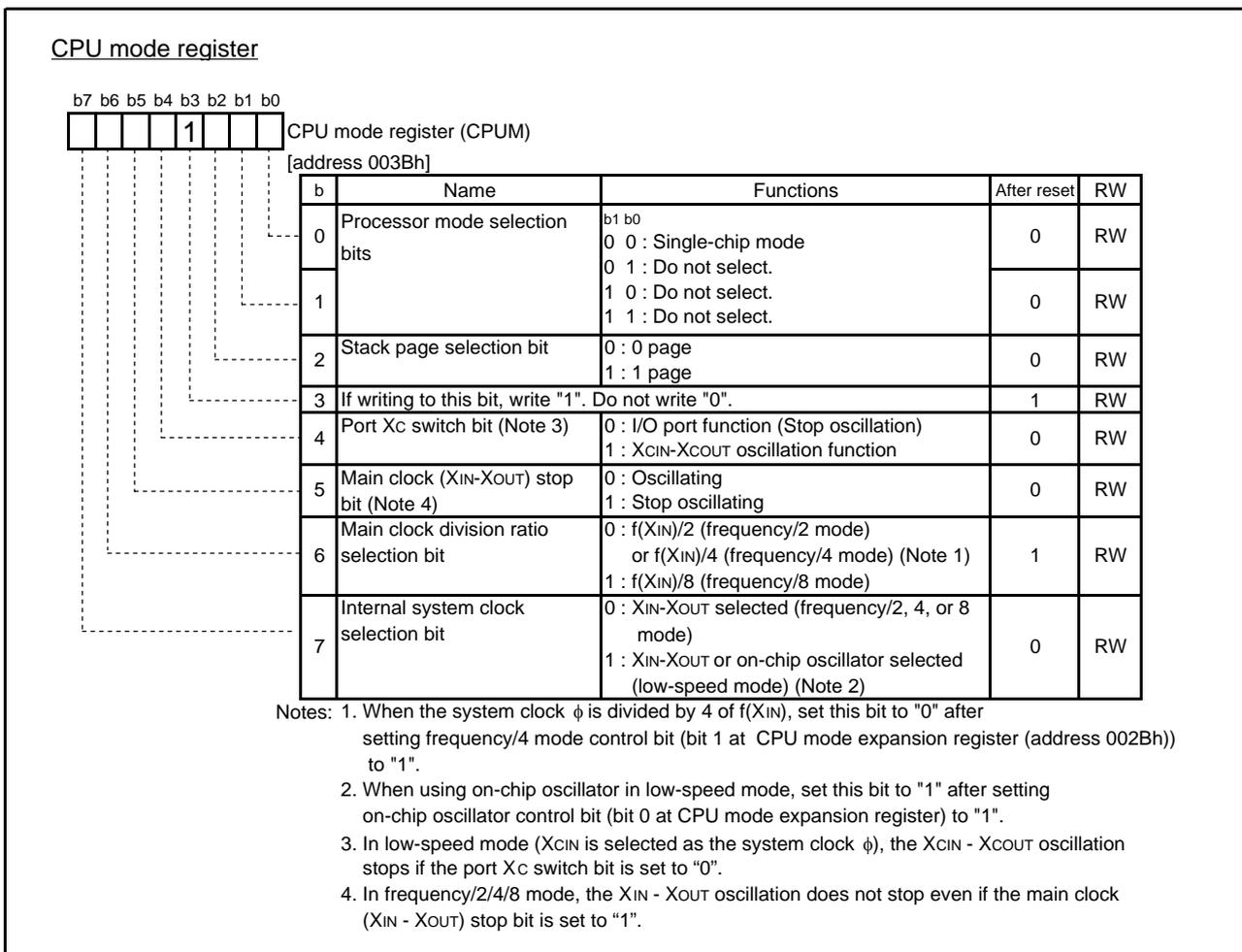


Fig.4.41 Structure of CPU mode register

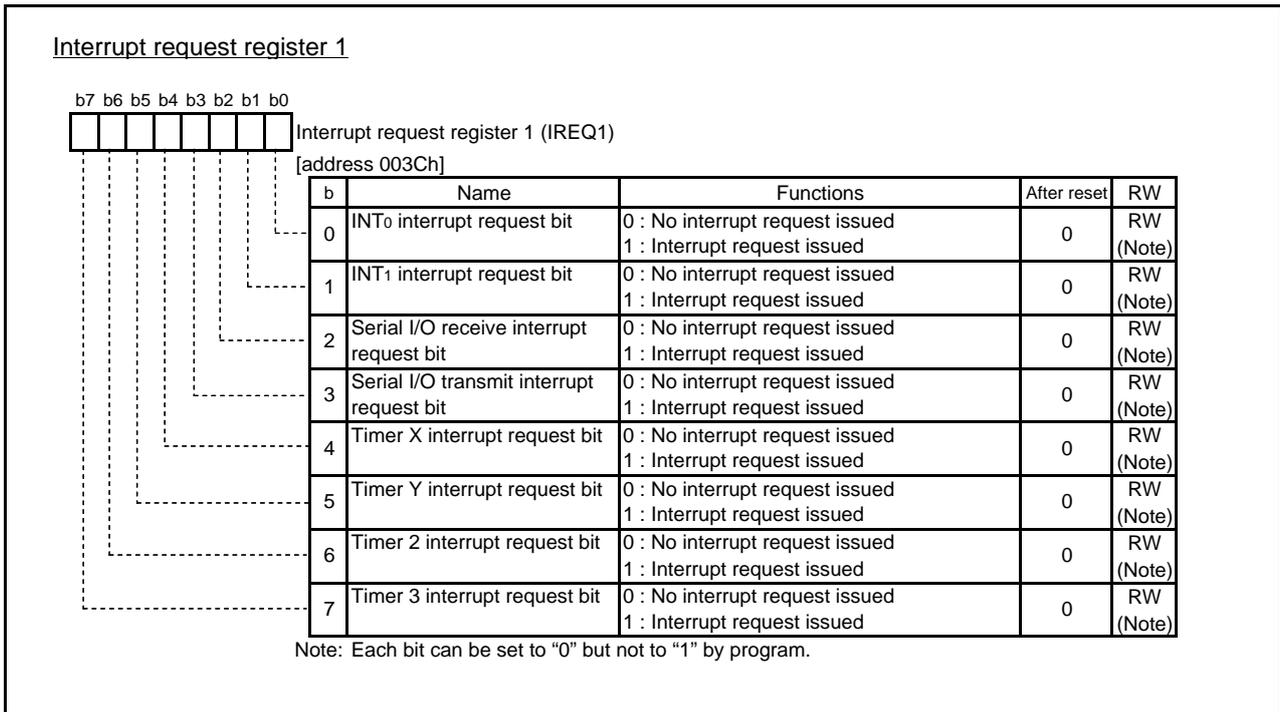


Fig.4.42 Structure of Interrupt request register 1

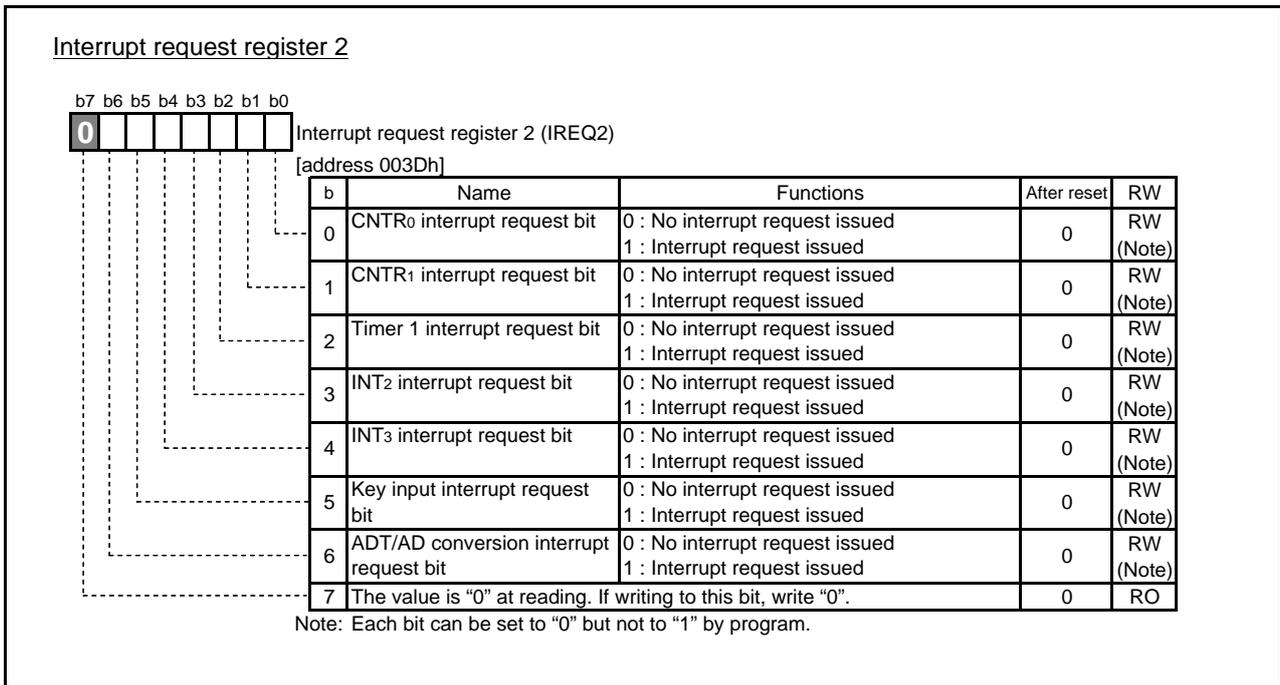


Fig.4.43 Structure of Interrupt request register 2

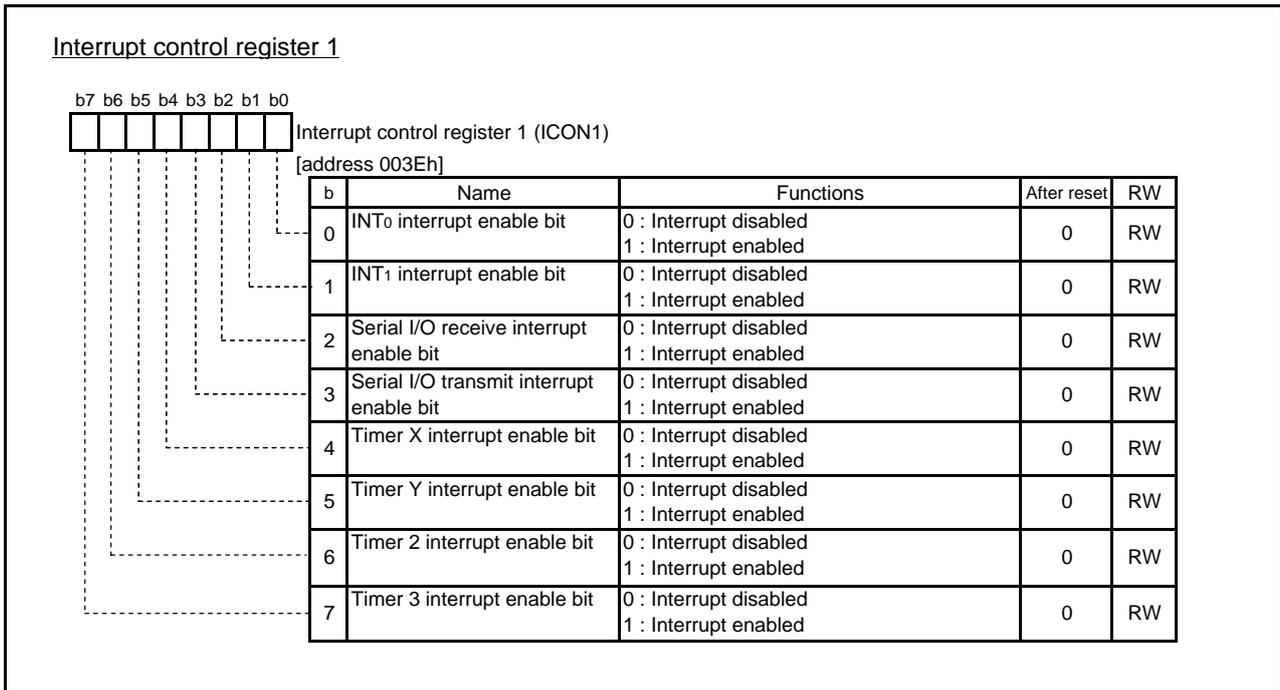


Fig.4.44 Structure of Interrupt control register 1

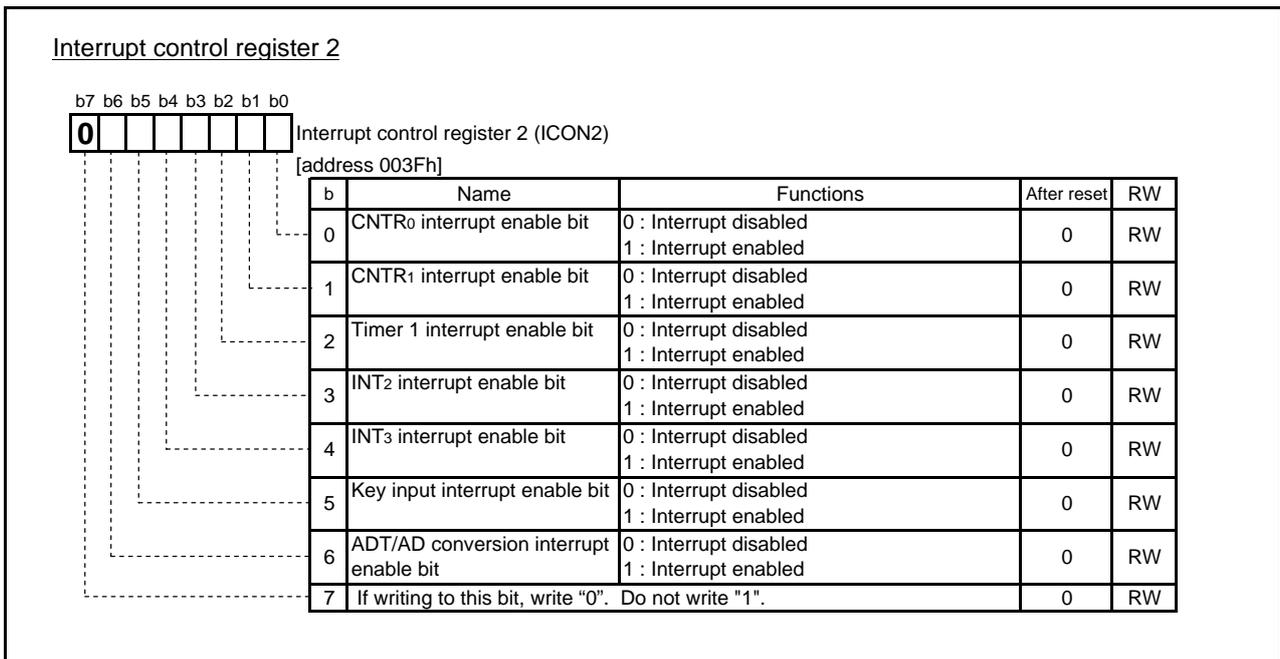


Fig.4.45 Structure of Interrupt request register 2

LCD display RAM

address \ bit		7	6	5	4	3	2	1	0	After reset	RW
		COM3	COM2	COM1	COM0	COM3	COM2	COM1	COM0		
0040h	LRAM0	SEG1			SEG0					Undefined	RW
0041h	LRAM1	SEG3			SEG2					Undefined	RW
0042h	LRAM2	SEG5			SEG4					Undefined	RW
0043h	LRAM3	SEG7			SEG6					Undefined	RW
0044h	LRAM4	SEG9			SEG8					Undefined	RW
0045h	LRAM5	SEG11			SEG10					Undefined	RW
0046h	LRAM6	SEG13			SEG12					Undefined	RW
0047h	LRAM7	SEG15			SEG14					Undefined	RW
0048h	LRAM8	SEG17			SEG16					Undefined	RW
0049h	LRAM9	SEG19			SEG18					Undefined	RW
004Ah	LRAM10	SEG21			SEG20					Undefined	RW
004Bh	LRAM11	SEG23			SEG22					Undefined	RW
004Ch	LRAM12	SEG25			SEG24					Undefined	RW
004Dh	LRAM13	SEG27			SEG26					Undefined	RW
004Eh	LRAM14	SEG29			SEG28					Undefined	RW
004Fh	LRAM15	SEG31			SEG30					Undefined	RW

Fig. 4.46 LCD display RAM

5. Reference

Data Sheet

3823 Group Data sheet

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REVISION HISTORY	3823 Group List of Registers
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Rev.	Date	Description	
		Page	Summary
1.00	Jan 10, 2007	—	First edition issued
2.00	Aug 08, 2007	17	Figure 4.28 CPU mode expansion register: Note2 revised
		22	Figure 4.37 Watchdog timer control register: Bit 7 revised
		24	Figure 4.41 CPU mode register: Notes 3 and 4 added

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